

# Mip Timing Detector for CMS at HL-LHC

---

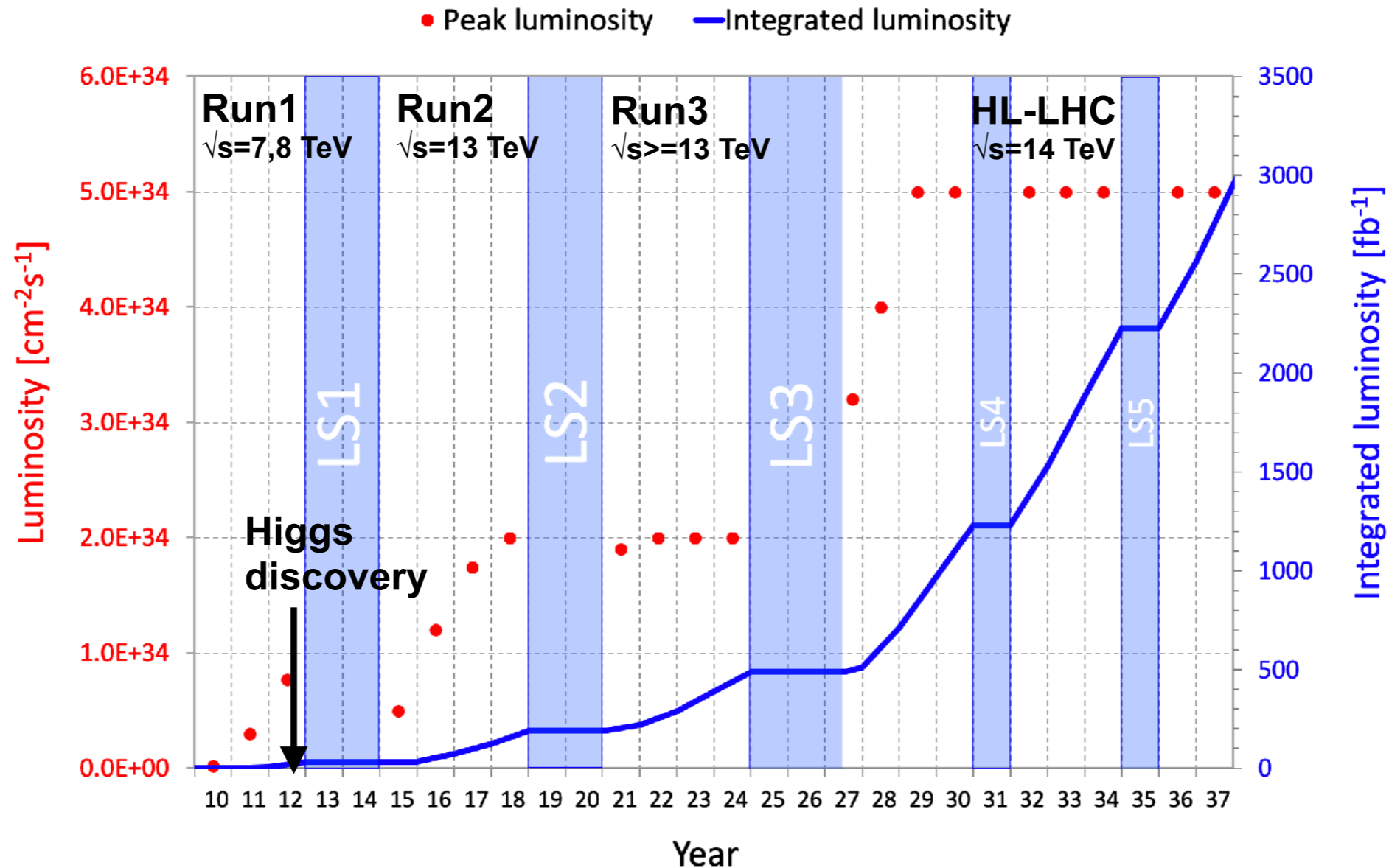
P. Meridiani  
INFN Roma

INFN-Rome seminar 1<sup>st</sup> March 2021

## Outline

- ➔ HL-LHC physics, motivation for a precision timing detector and physics impact
- ➔ The MTD design
- ➔ Timing with LYSO scintillating crystals: the Barrel Timing Layer

# HL-LHC

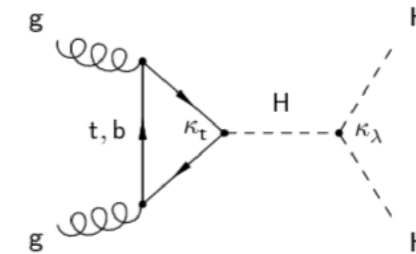


**HL-LHC after LS3 (>2027):** instantaneous luminosity increased beyond  $5\text{E}34 \text{ cm}^{-2} \text{ s}^{-1}$ ,  $\sim 300 \text{ fb}^{-1}$  per year ( $\sim$ same luminosity collected in Run1+Run2+Run3),  $\sqrt{s}=14 \text{ TeV}$

**Goal: at least  $3000 \text{ fb}^{-1}$  after 10 years of operation**

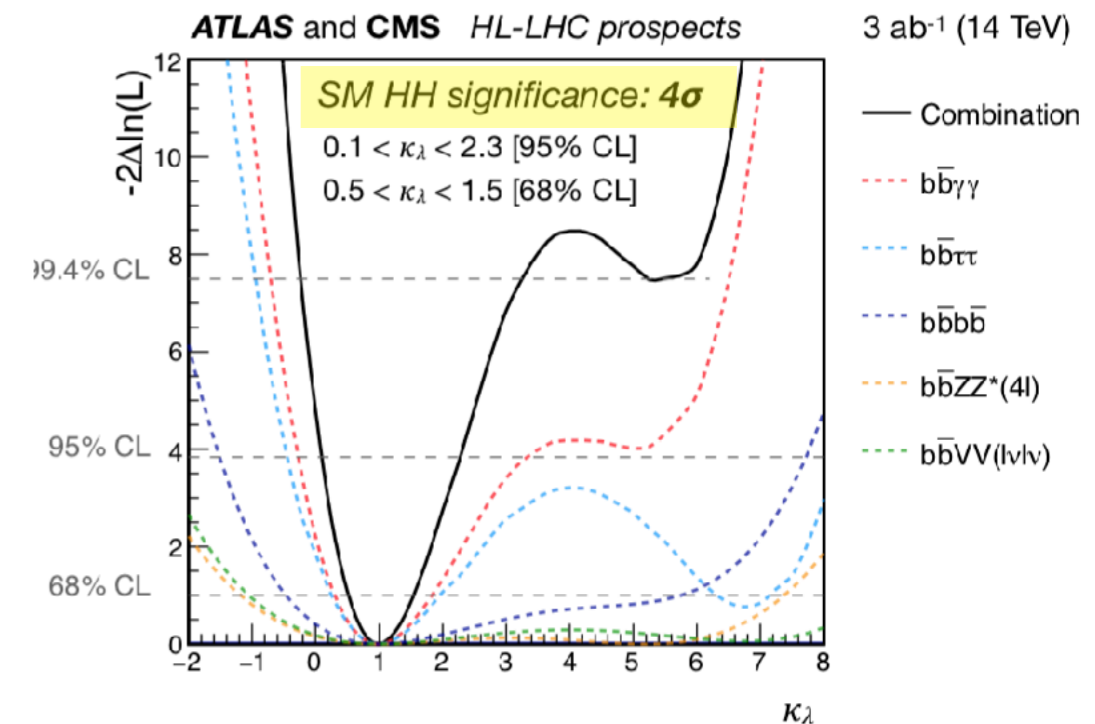
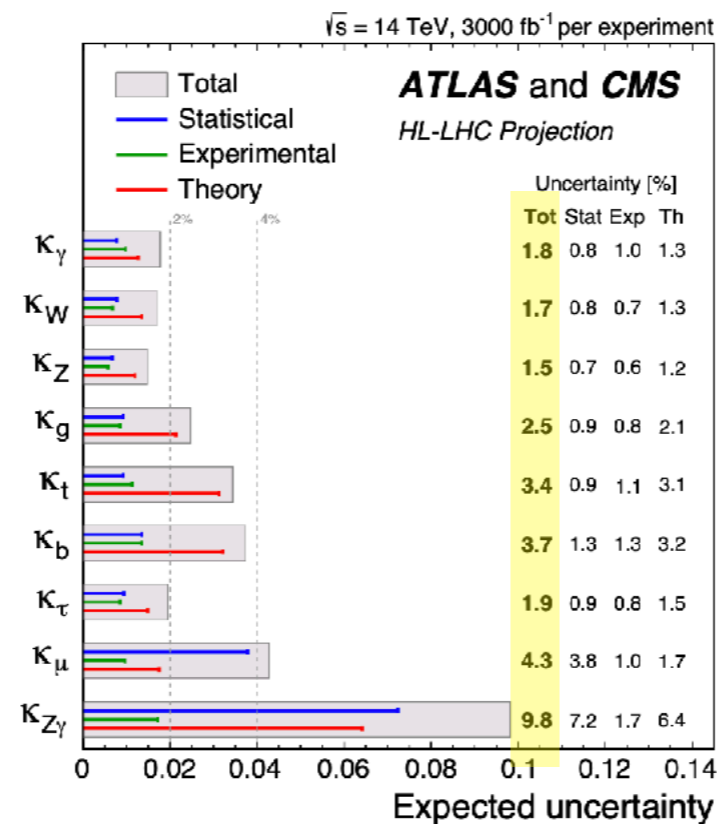
## Exploit ultimate LHC physics potential, with $>3000 \text{ fb}^{-1}$

Ultimate precision for some Higgs couplings at few %



### Higgs physics

- couplings precision measurements
- Higgs self-coupling from HH production

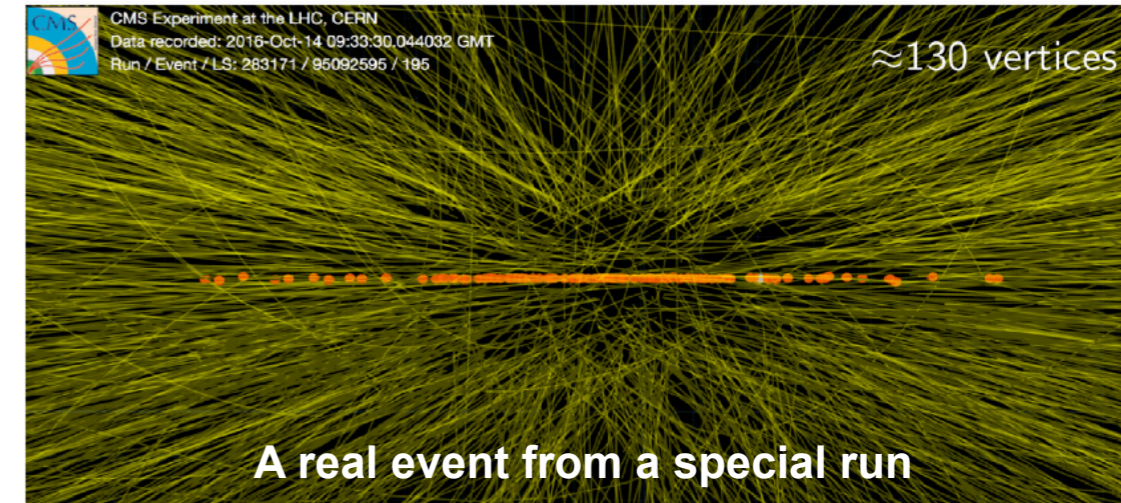
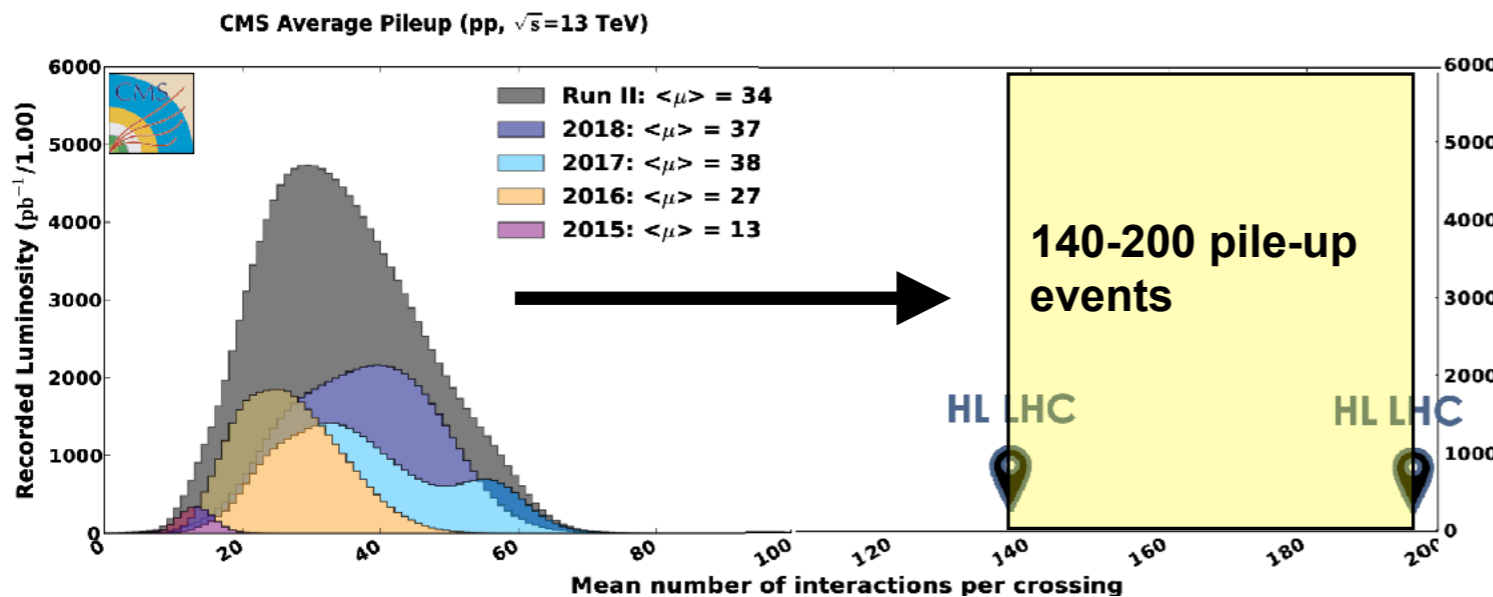


### BSM direct searches: leave no stone unturned

- No sign of BSM so far. New physics not in the explored mass range or more weird
- **Novel ideas to explore regions so far not covered (long lived, low mass...)**

### Indirect search for BSM: precision measurements in SM, Top or B-physics

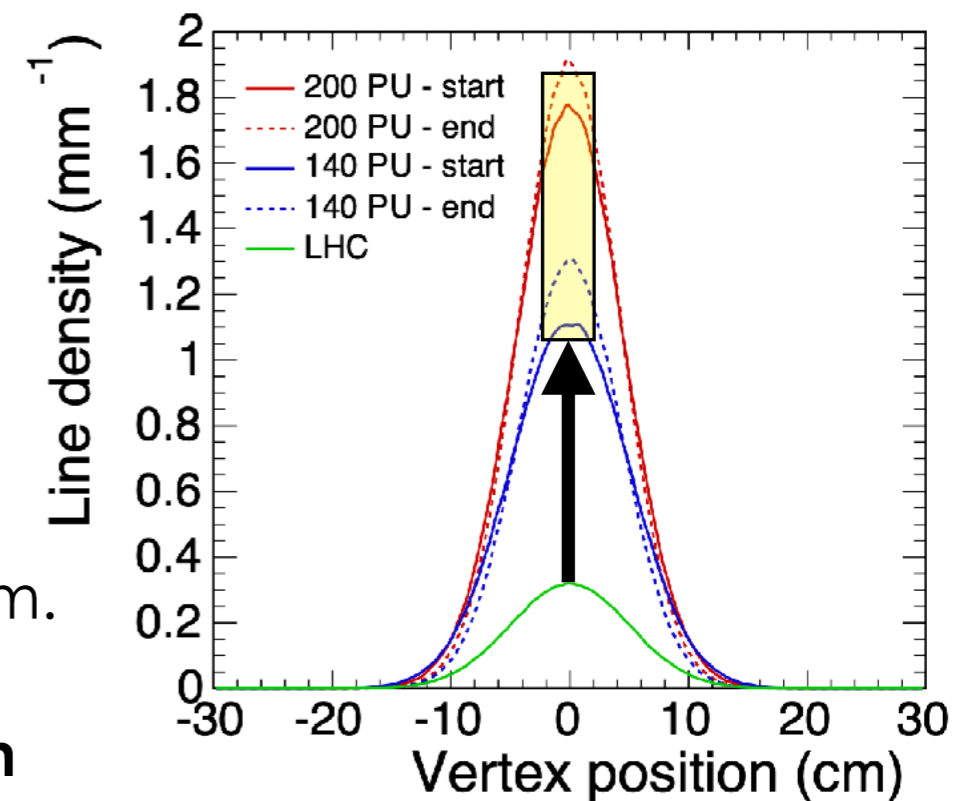
# THE CHALLENGE OF HL-LHC



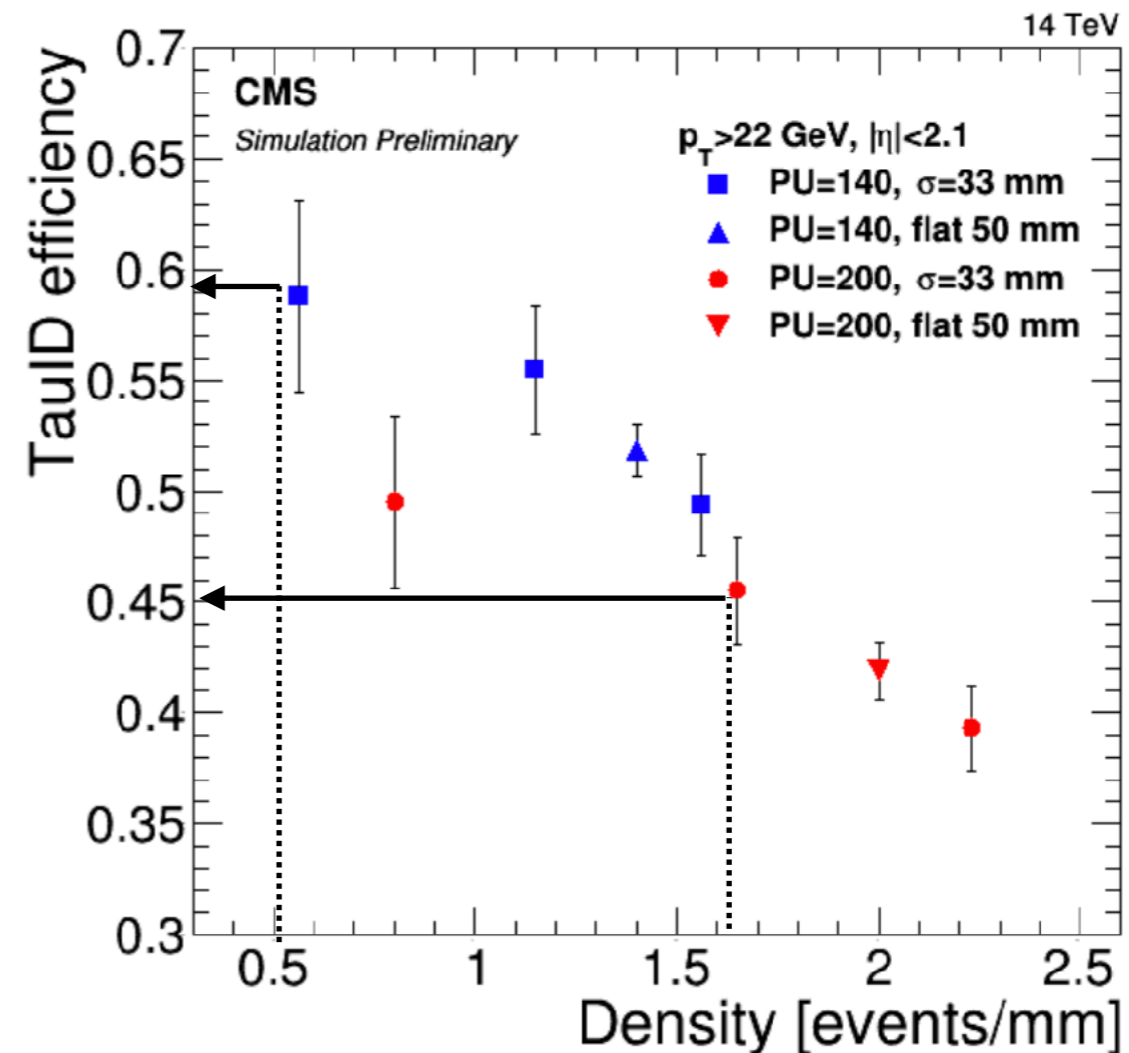
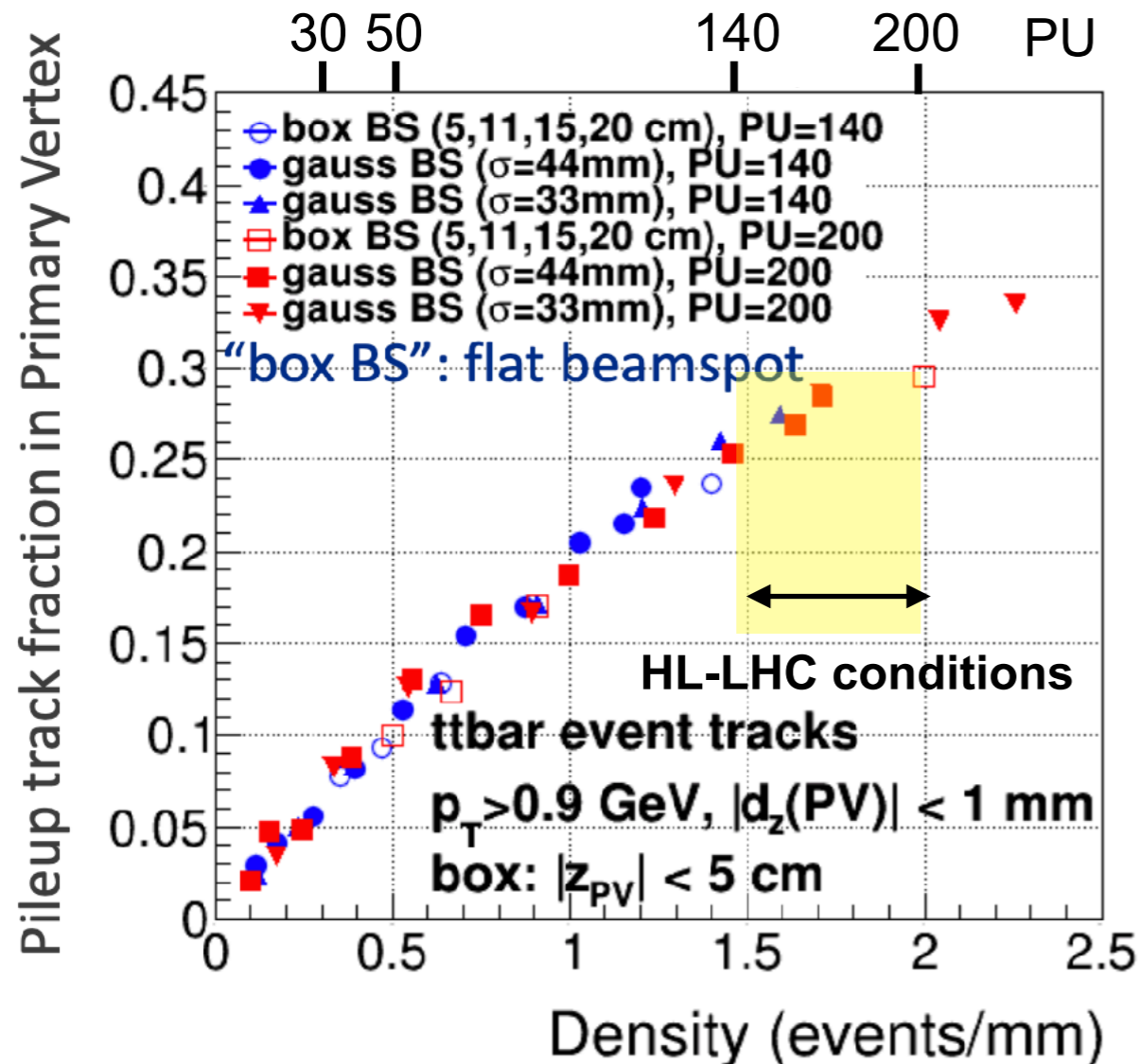
## Challenging PU conditions at HL-LHC.

### Increase in inst lumi comes with higher number of interactions per bunch-crossing

- Thousands of tracks, calorimeters clusters, etc to be associated with respective production vertex
- Event density  $>1.5\text{mm}^{-1}$  (x 5-7 compared to LHC) will challenge tracker spatial resolution
- Track-vertex association: now done requiring  $|dz| < 1\text{mm}$ . PU contamination deteriorates event reconstruction
- New idea for PU mitigation: **exploit beam spread also in time**



# EFFECT OF PILE-UP IN EVENT RECO

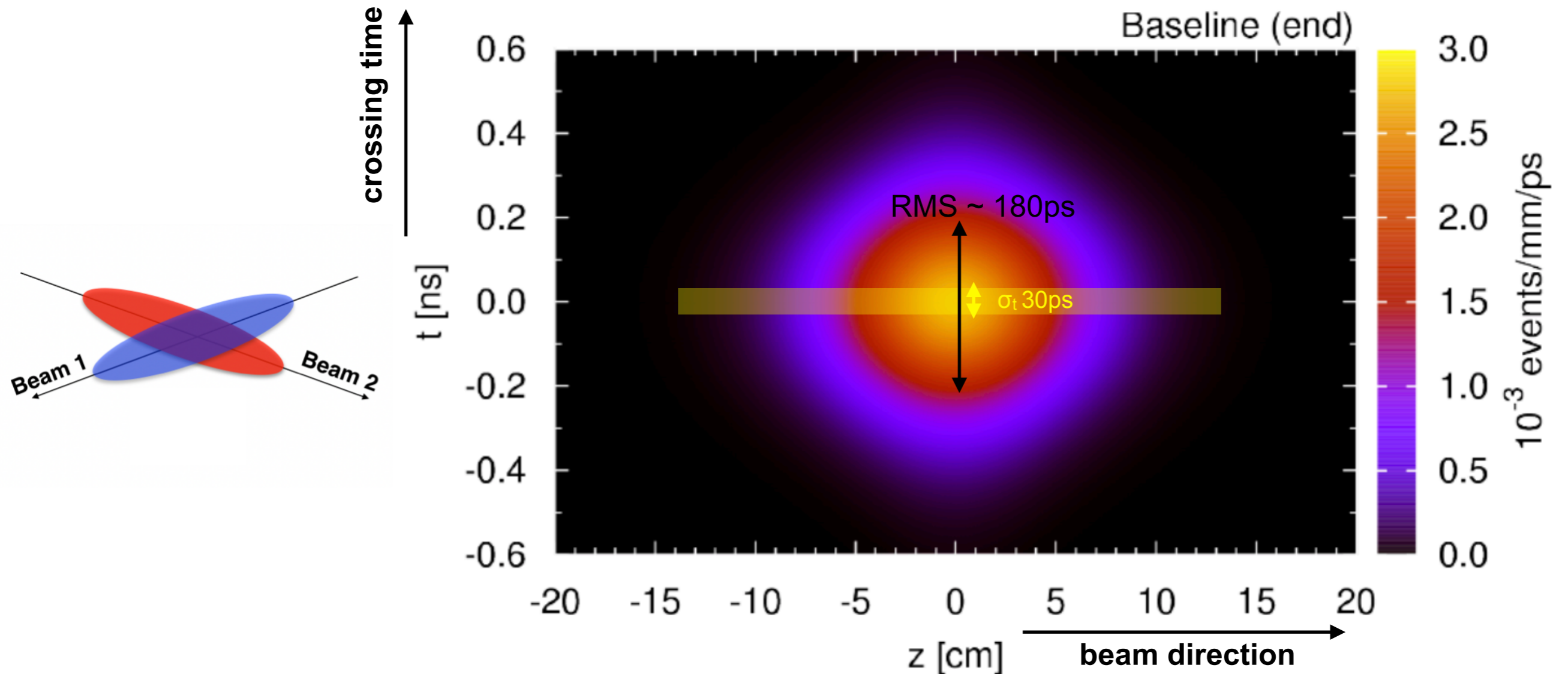


Fraction of **pile-up tracks** associated to the hard-scattering event can reach up to **30% at PU200 conditions**. Track based informations will be no longer PU free

**Significant impact on object reconstruction from PU contamination:** e.g.  $\tau$  lepton identification efficiency reduced by 20-30%

Similar effects also for global quantity (eg missing  $E_T$ ). **Performance reduction impacts at analysis level, reducing gain from luminosity increase**

# BEAM SPOT SPREAD



Bunch crossing extends in space (along the beam direction) and time

**Nominal LHC optics: RMS in space ~5cm, in time ~ 180ps**

If beam spot can be sliced in ~30ps time exposures, pile-up in a single exposure drops to current LHC pile-up levels

# CMS UPGRADE FOR HL-LHC

## New Tracker

- Radiation tolerant - high granularity - less material
- Tracks ( $P_T > 2\text{GeV}$ ) in hardware trigger (L1)
- Coverage up to  $\eta \sim 4$

## Muons

- Replace DT and CSC FE/BE electronics
- Complete RPC coverage in forward region (new GEM/RPC technology)
- Muon-tagging up to  $\eta \sim 3$

## Barrel ECAL

- Replace FE/BE electronics
- Cool detector/APDs
- Timing

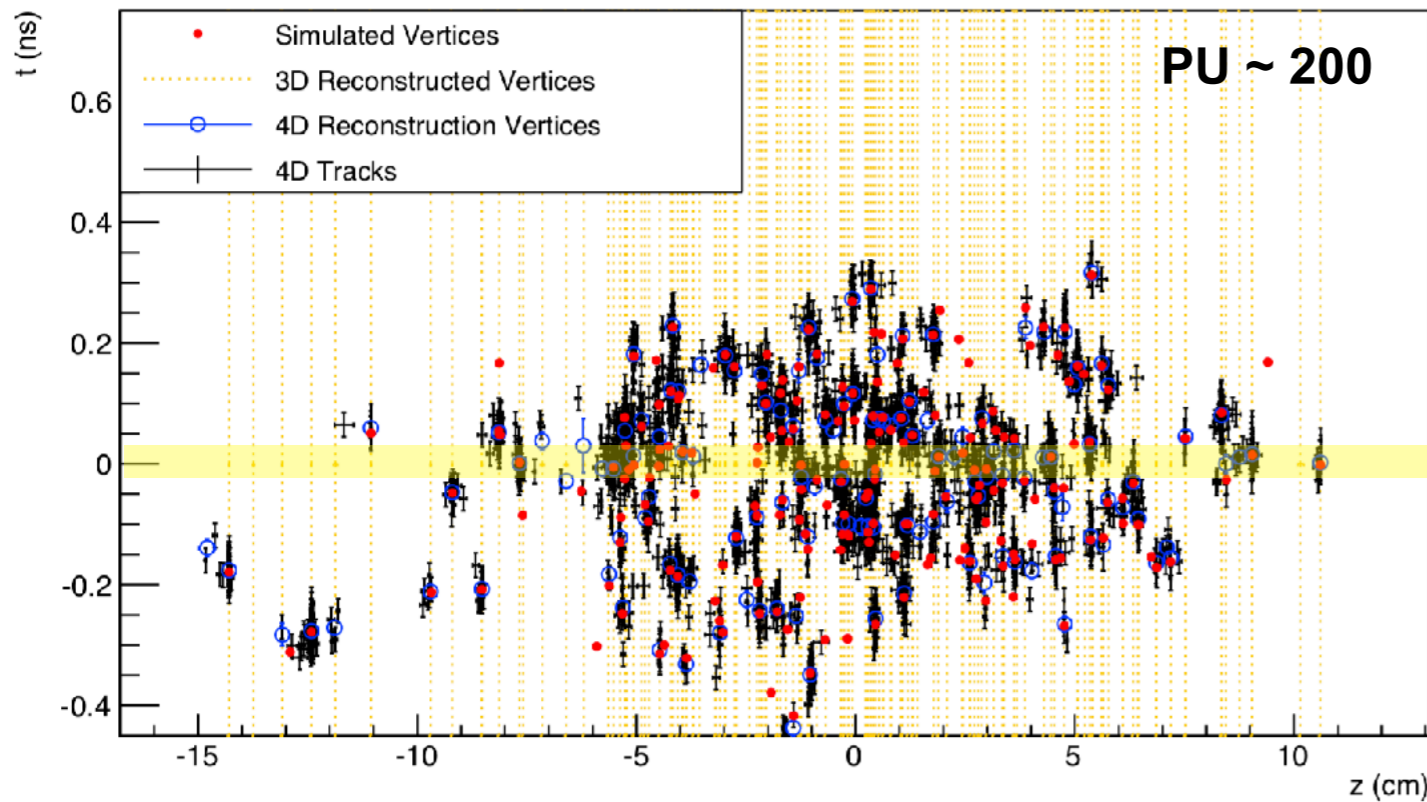
## New Endcap Calorimeters

- Radiation tolerant
- High granularity
- Timing capability

## Trigger/DAQ

- L1 (hardware) with tracks and rate up  $\sim 750\text{ kHz}$
- L1 Latency  $12.5\ \mu\text{s}$
- HLT output rate  $7.5\text{ kHz}$

## New MIP Timing Detector

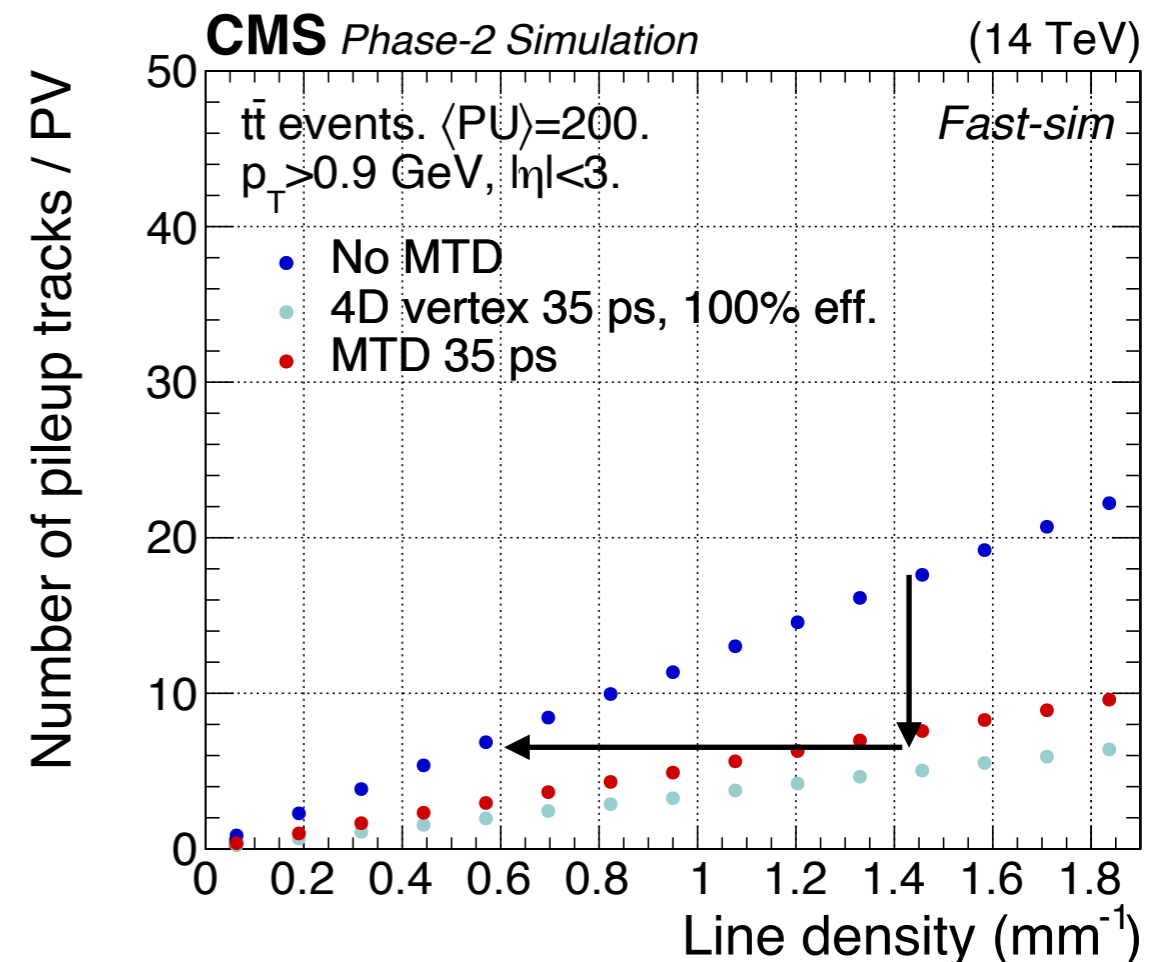


## High precision timing (~30ps) for tracks

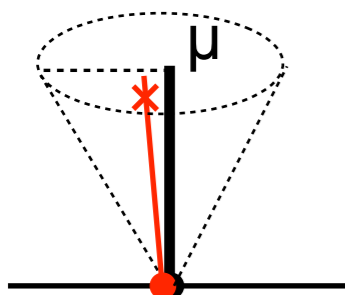
- Can reconstruct vertex not only in space but also time
- timing (time-of-flight) can also be exploited for particle ID (BSM searches and flavour physics)

## Track-vertex association using track timing

- **3-5 reduction of PU contamination** using also time at vertex information eg  $|\Delta t(\text{track-vertex})| < 3 \sigma_t$
- PU contamination per vertex reduced to current LHC conditions

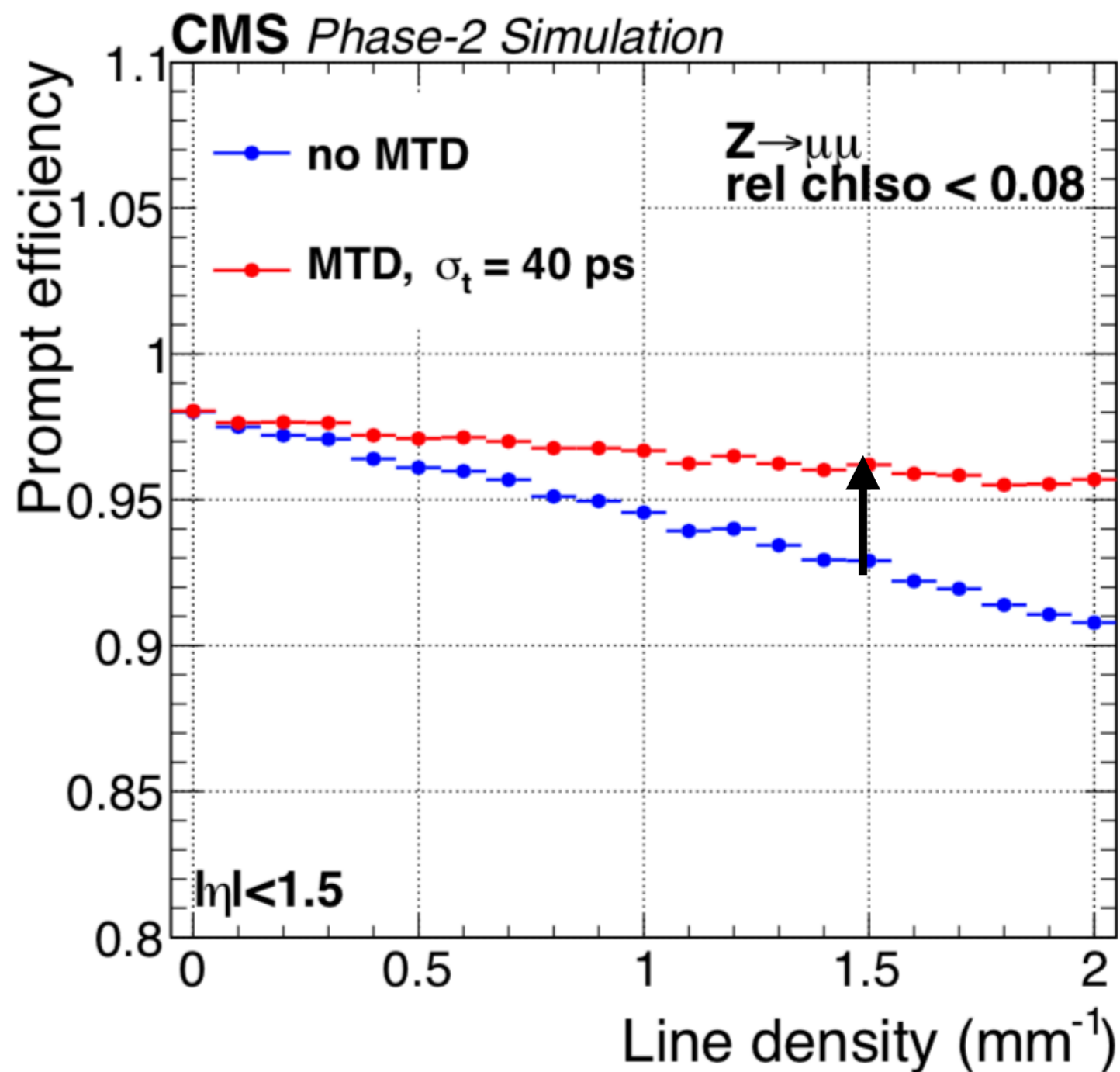




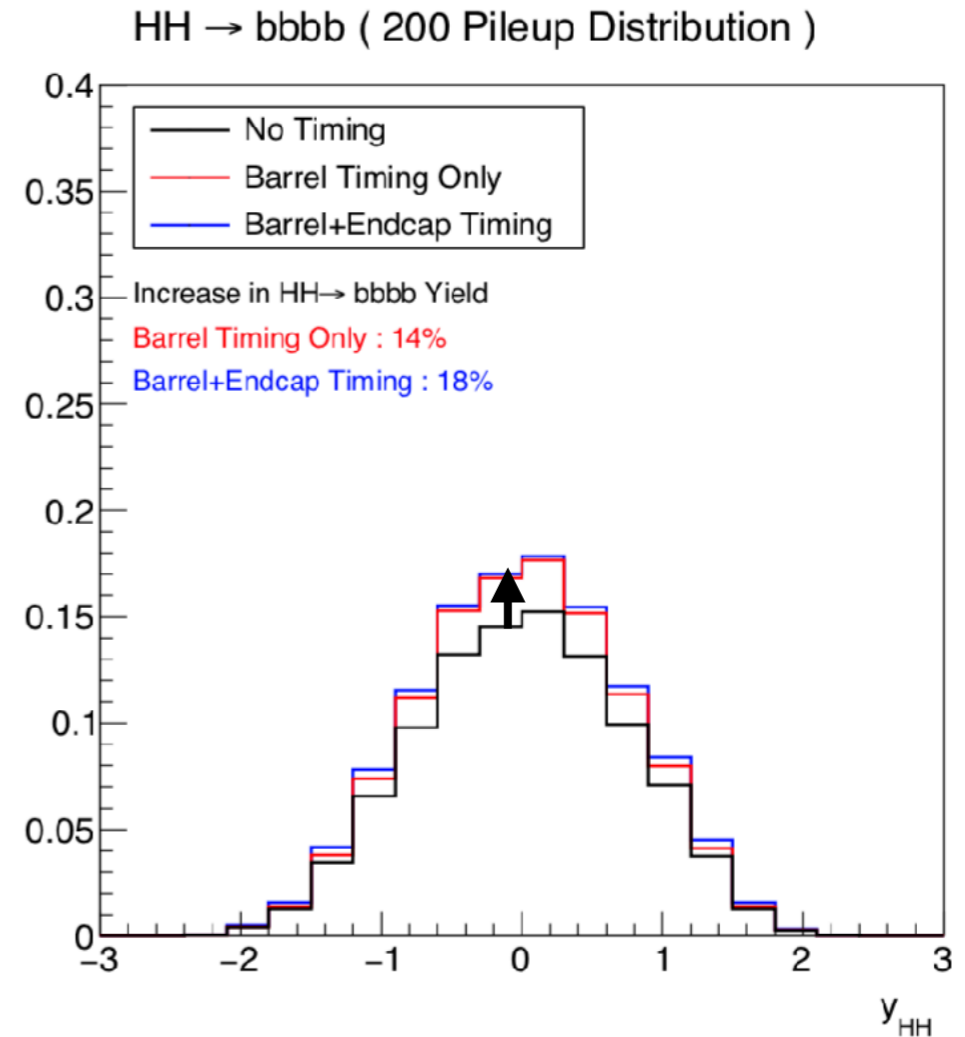
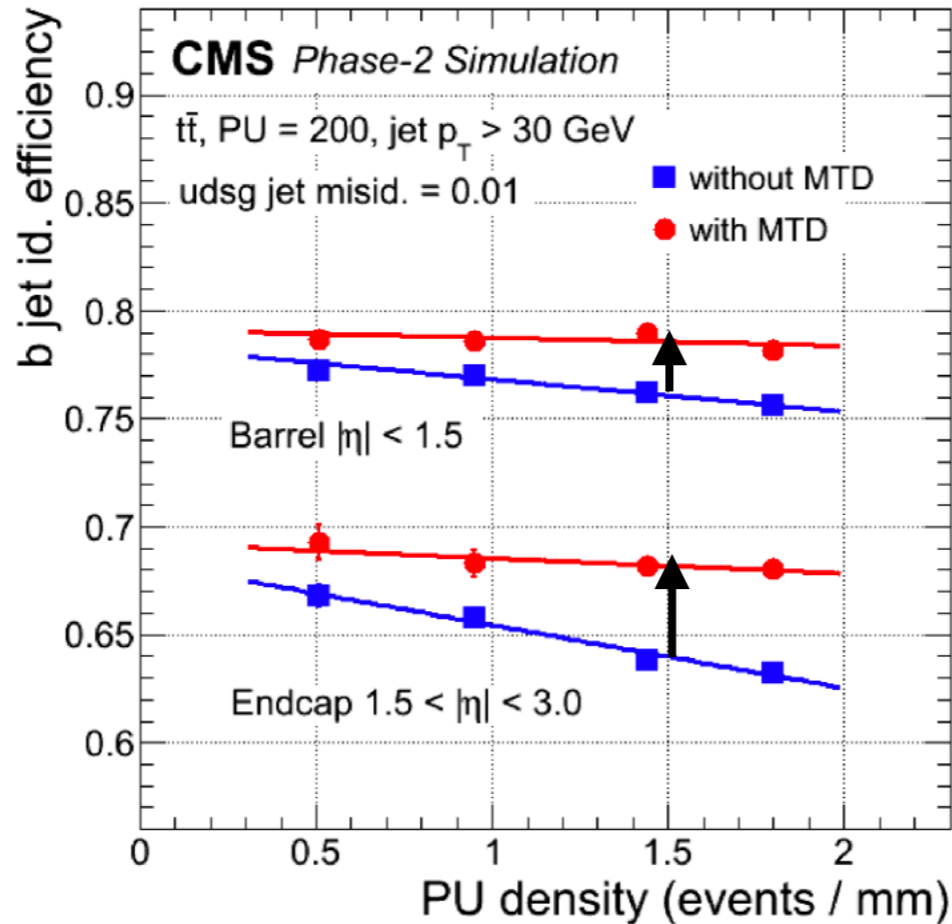
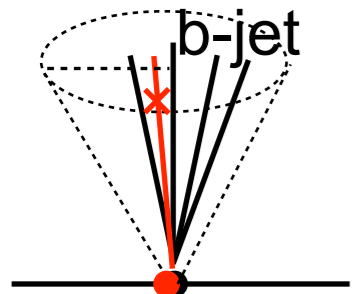


## Simplest (yet effective) application: lepton isolation

- Isolated leptons main probes at LHC in several final states (eg.  $H \rightarrow ZZ \rightarrow 4l$ ,  $H \rightarrow \tau\tau$ , ...)
- Reduction of PU contamination in isolation cone: **gain up 15-20% for lepton identification**



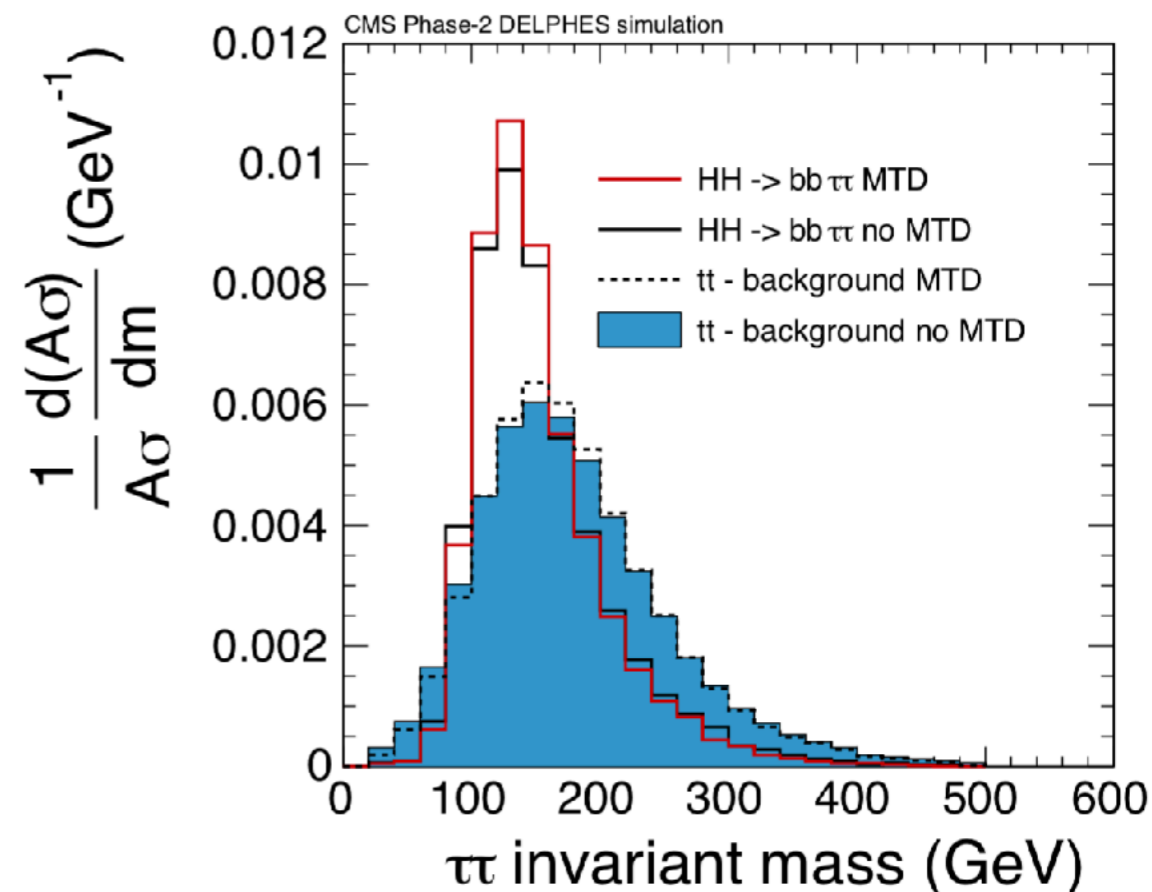
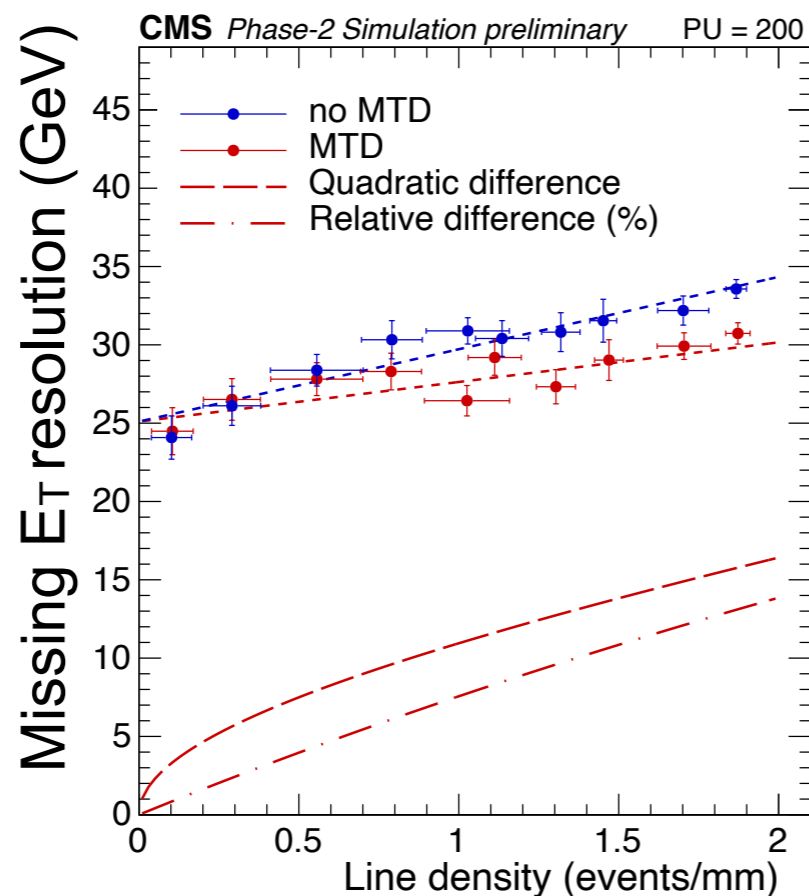
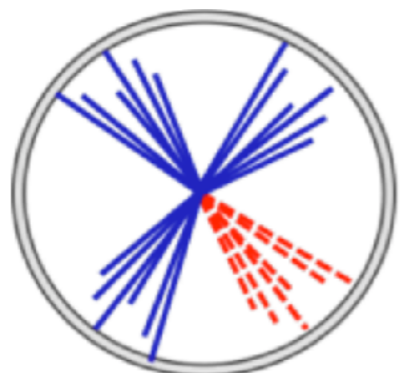
# MTD IMPACT: B-TAGGING



Reduction of PU contamination helps to maintain performance at high pile-up for more complex algorithms, such as identification of displaced jets, aka b-tagging

Significant acceptance gains ( $\sim 20\%$ ) when looking at final states with several b (e.g. HH  $\rightarrow$  bbbb, HH  $\rightarrow$  bbyy)

# MTD IMPACT: MISSING $E_T$



Also gain in resolution for global event properties, such as momentum balance in the transverse plane, missing transverse energy

Improvements eg. for reconstruction of invariant mass for events with neutrinos (e.g.  $H \rightarrow \tau\tau$ ) or searches (e.g. SUSY)

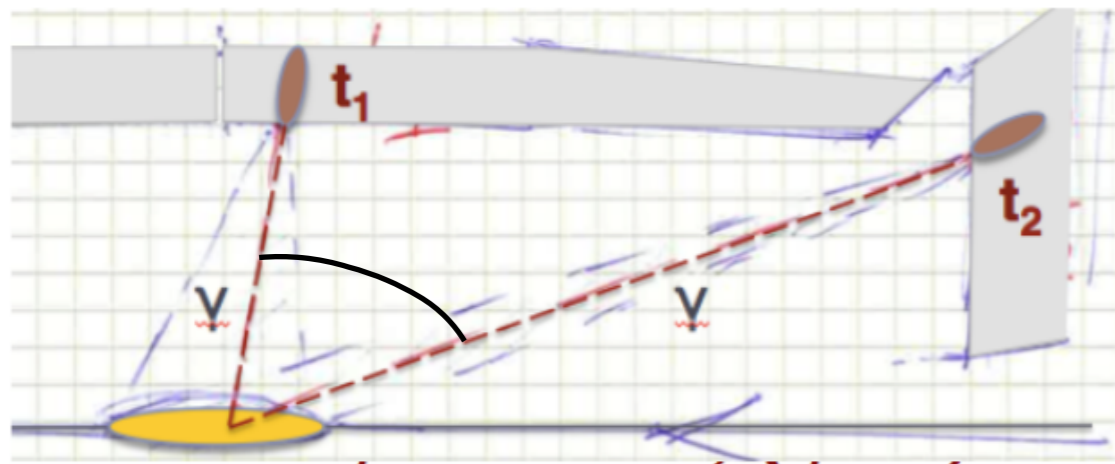
# TRACK + NEUTRAL TIMING

## Track-timing complements timing capabilities in upgraded CMS calorimeters

- Barrel: ECAL upgraded electronics, precise timing for  $\gamma \sim 30\text{ps}$  above  $E > 40\text{-}50\text{ GeV}$
- Endcap: new HGCAL, precise timing for  $\gamma \sim 50\text{ps}$  above  $p_T > 3\text{-}4\text{ GeV}$

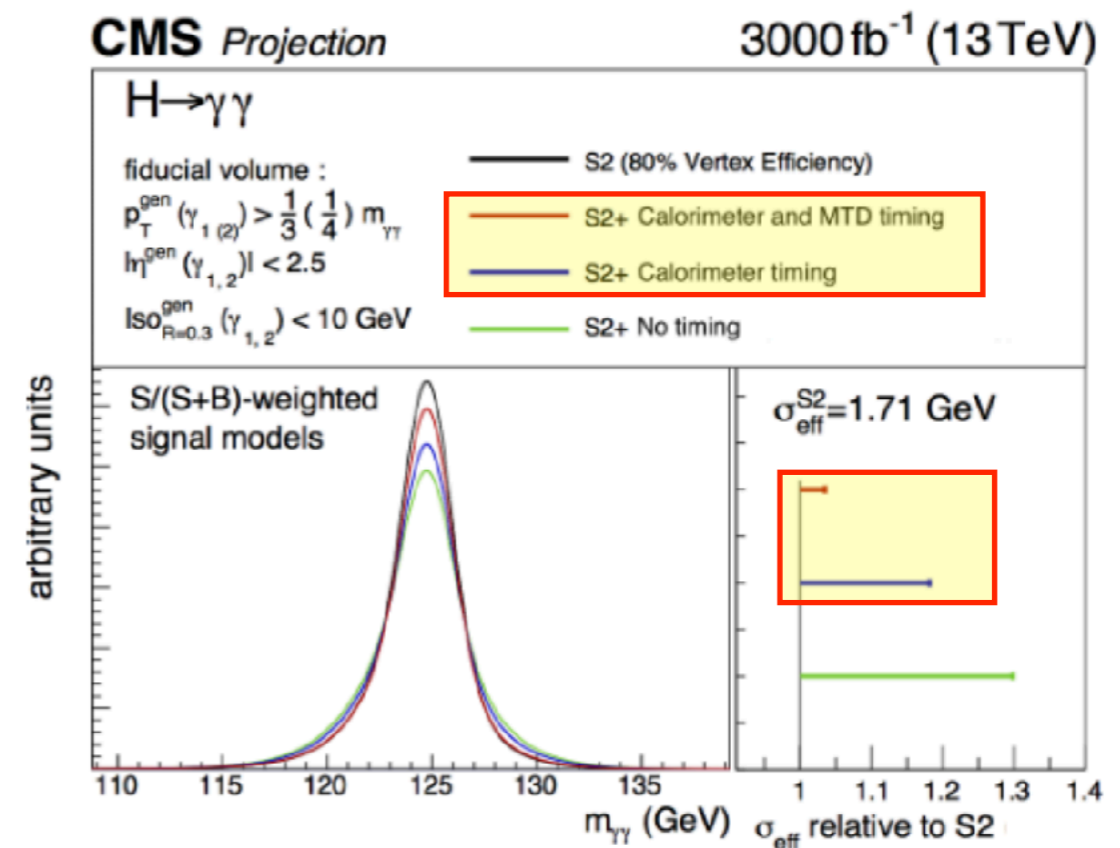
## Track+neutral timing can be combined in PU robust particle flow algorithms (being developed)

Another example: identify  $H \rightarrow \gamma\gamma$  production vertex using the track+ECAL timing information without a “pointing” calorimeter



### ECAL photon time + vertex time from MTD

recover  $\sim 80\%$  vertex identification efficiency, similar to LHC current performance



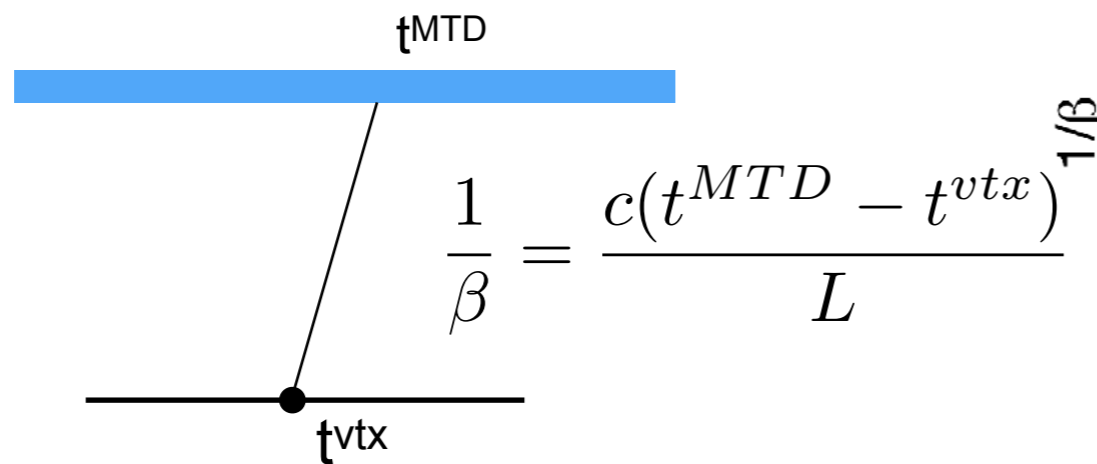
# PU MITIGATION AT ANALYSIS LEVEL

**Improvements on event reconstruction from timing impact at analysis level across the full HL-LHC physics program**, leveraging on gains on several observables and physics objects

For many channels, **the gain is equivalent to 25-30% increase of integrated luminosity**

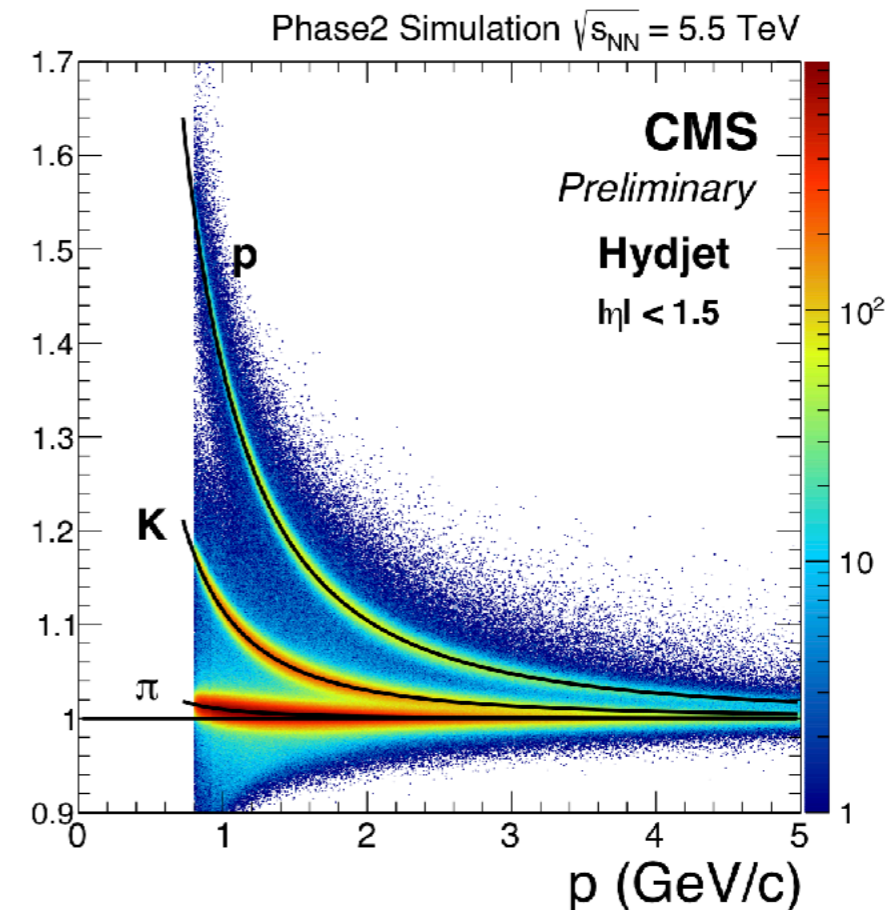
Signal	Physics measurement	MTD Impact
HH	<b>+25%</b> gain in signal yield → Consolidate searches	Isolation, b-tagging, MET
H→γγ H→4leptons	<b>+25%</b> statistical precision on xsecs → Couplings	Isolation, Vertex identification
VBF+H→ττ	<b>+30%</b> statistical precision on xsecs → Couplings	Isolation VBF tagging, MET
EWK SUSY	<b>40%</b> reducible background reduction → +150 GeV mass reach	MET

# TOFPID: FLAVOUR PHYSICS



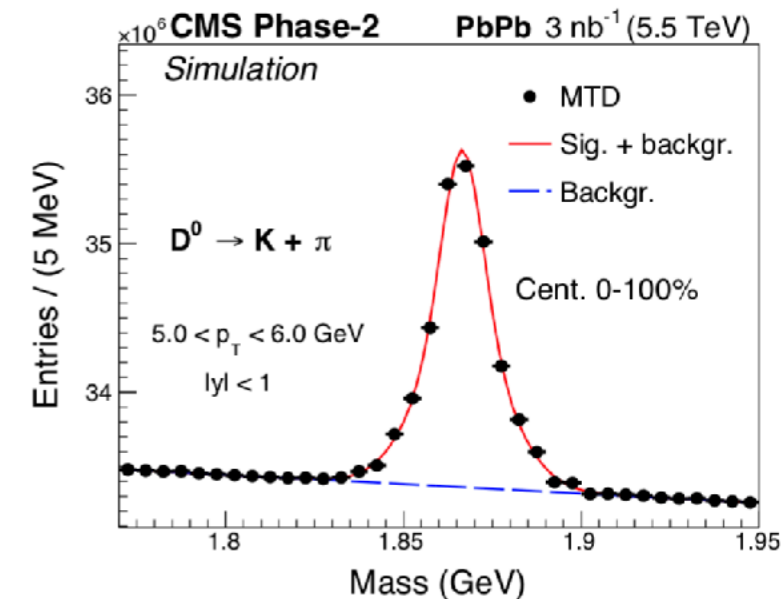
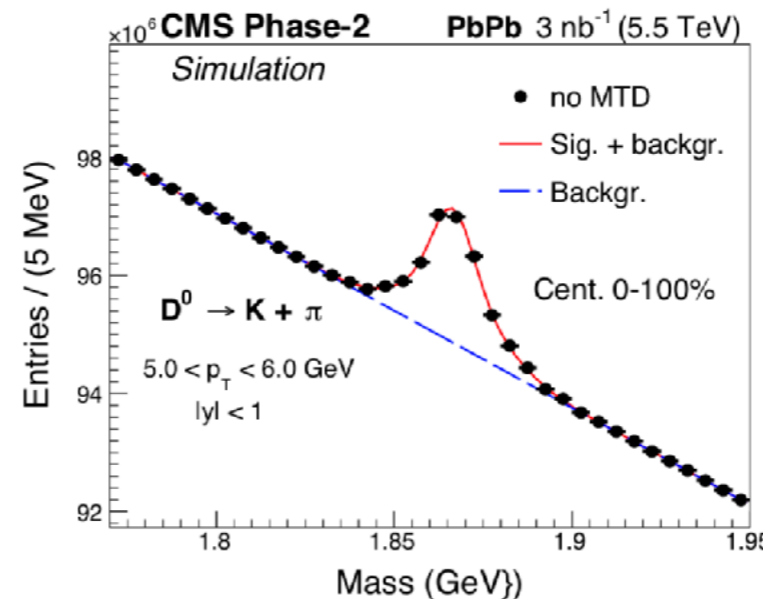
New capability for CMS:  
**Time-of-flight particle identification**  
(TOFPID)

$\pi$ /K separation up to 2-3 GeV and K/p separation up to 5 GeV

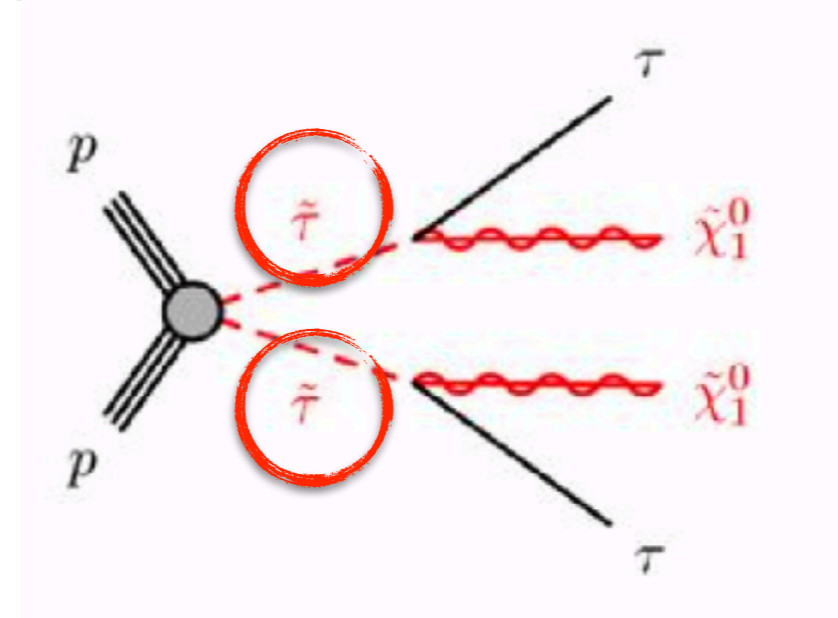


Example of TOFPID:

- **reduction of combinatorial background of a factor ~3** for  $D \rightarrow K + \pi$  in PbPb events
- Expect gains in general for flavour physics: e.g.  $B \rightarrow K^*(\rightarrow K\pi)\mu\mu$

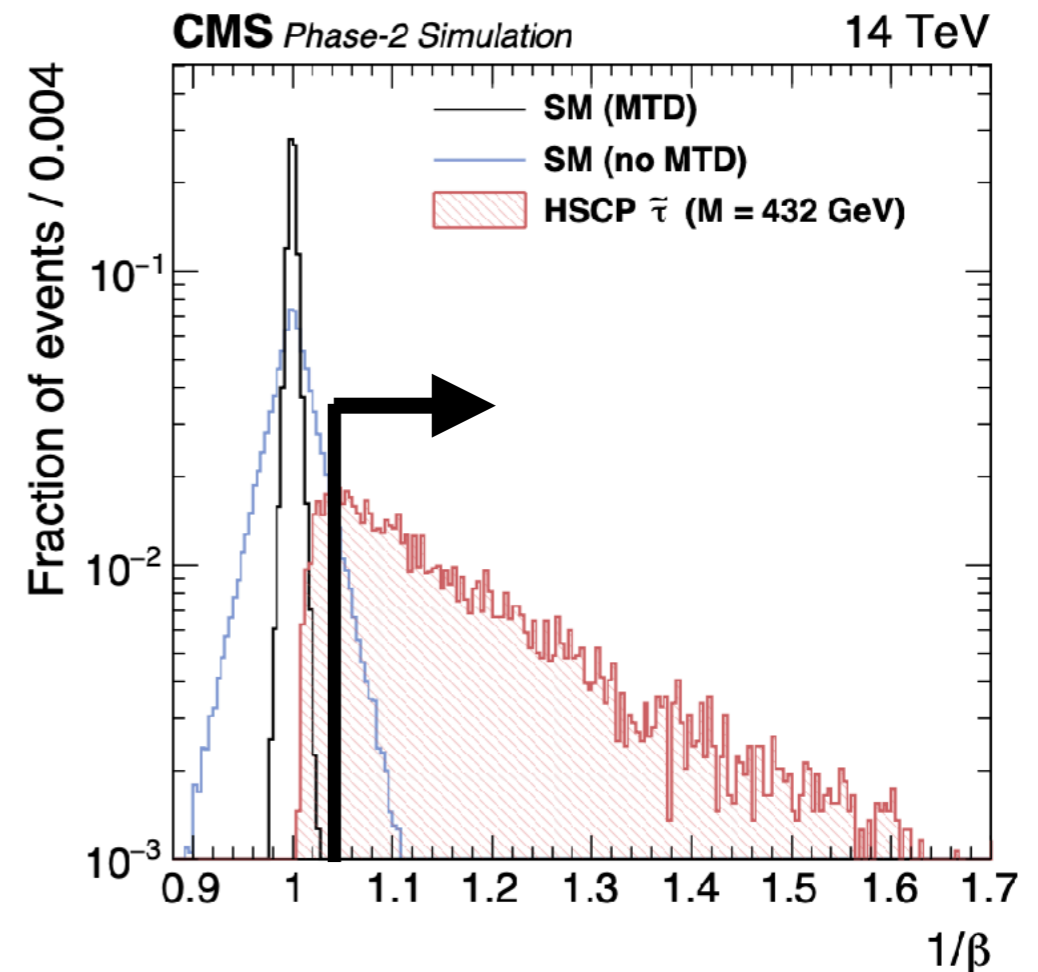


**TOFPID can also be applied in BSM searches**, eg heavy stable charged particle (staus, gluinos,...)  
– a new handle in addition to  $dE/dX$

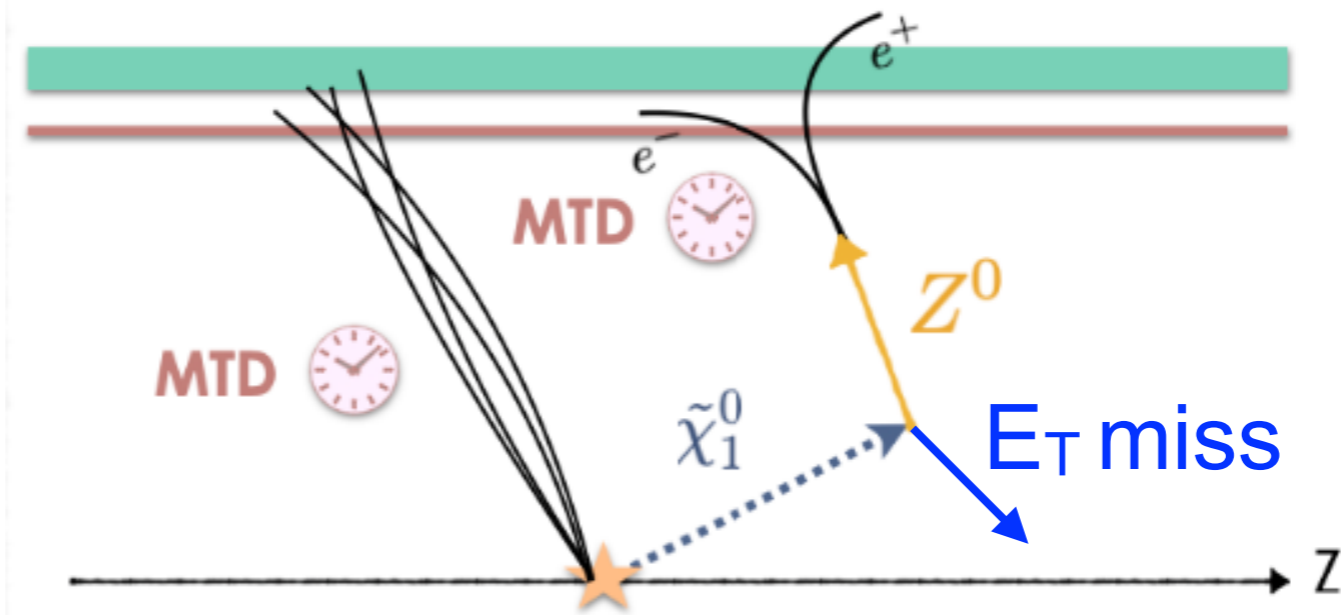
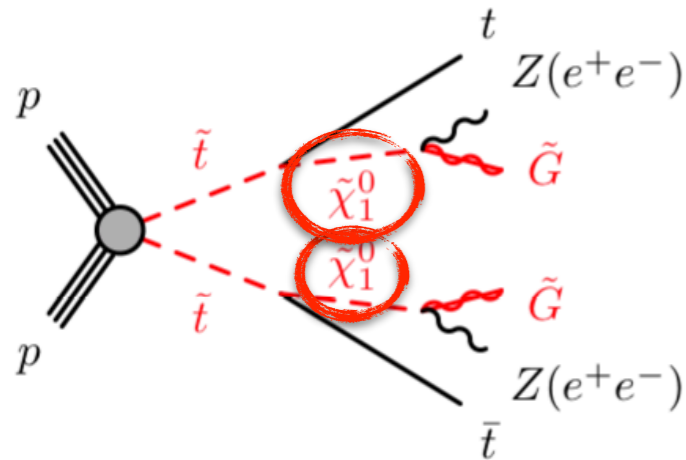


**$1/\beta$  resolution improved by 1 order of magnitude**

large reduction of SM background  
→ signal acceptance gain



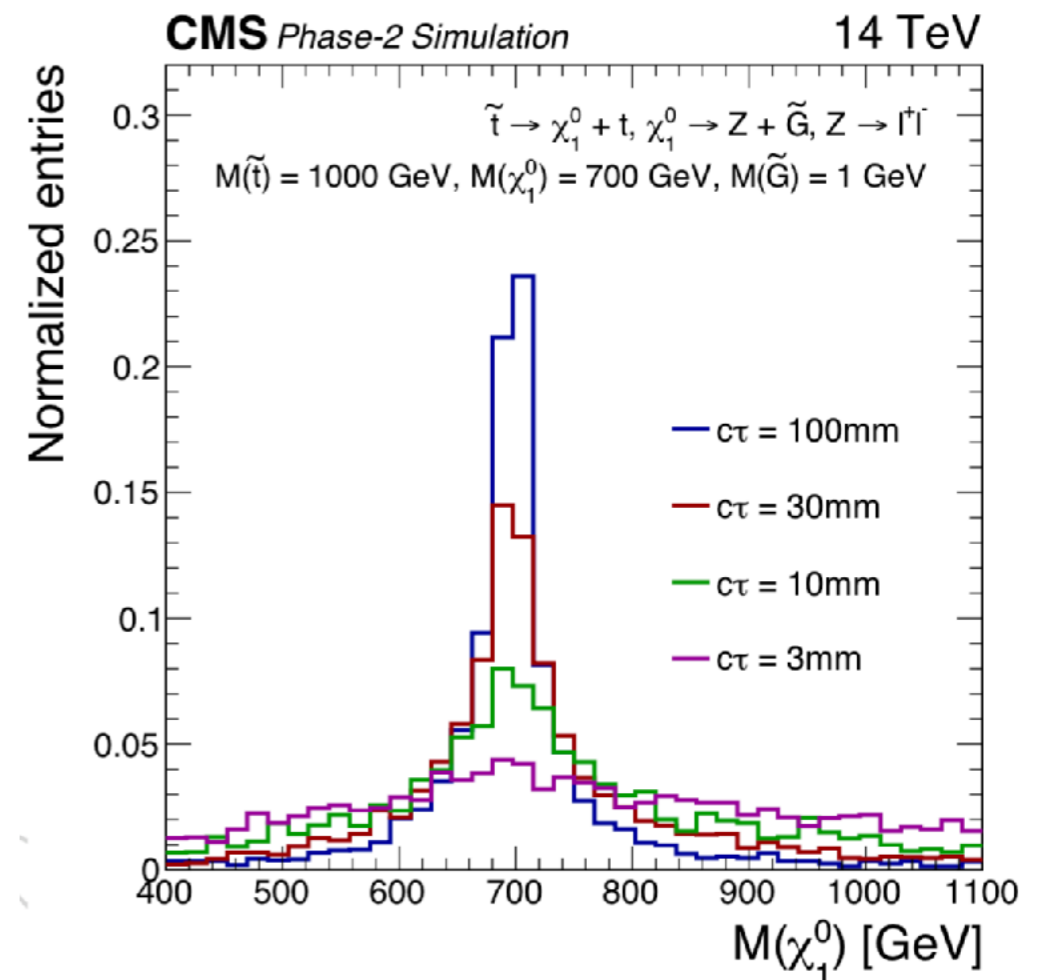
# BSM: DISPLACED OBJECTS



**Eg: long lived neutral particle, neutralino, decaying into Z+gravitino ( $E_T$  miss)**

Can close kinematics measuring  $\beta_{\text{neutralino}}$  from displaced vertex time (better resolution for longer decay distance)

**Neutralino mass can be reconstructed**





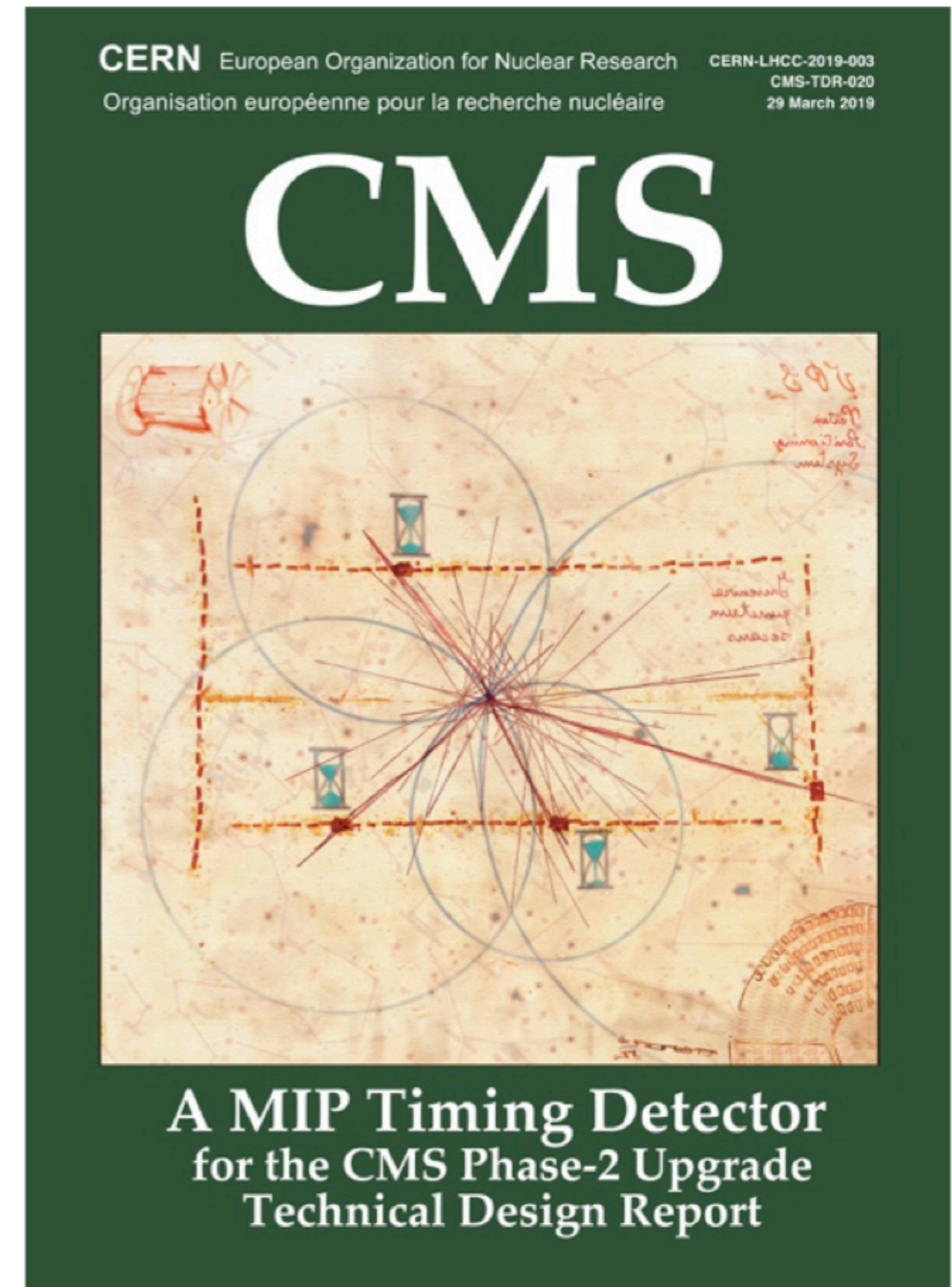
# THE CMS MIP TIMING DETECTOR

## MTD project approved by CERN research board at the end of 2019

- Culmination of an R&D phase started in 2013, exploring various technologies for timing

## Several Italian institutions involved

- MiB, Rome, Padova, Torino
- Rome has responsibility for qualifying LYSO crystal vendors and crystal QA/QC during construction phase

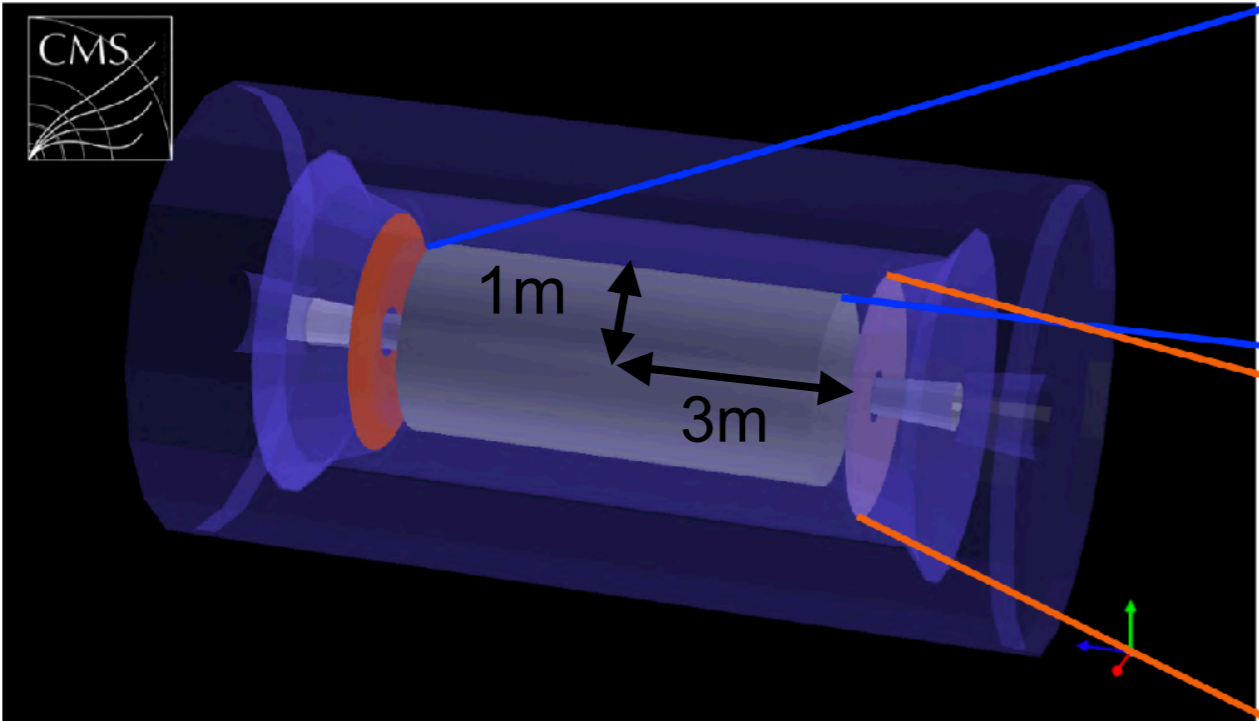


<https://cds.cern.ch/record/2667167>

Ideal solution: a 4D capable tracker, but technology not yet mature enough.  
R&D ongoing for future colliders

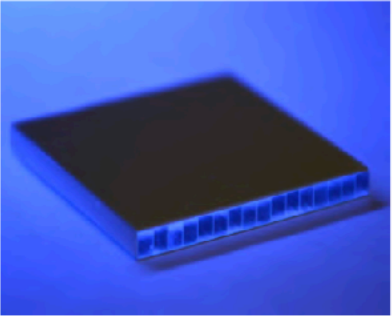
## CMS solution: 2 thin timing layers for charged particles installed between tracker and calorimeters

- Almost hermetic coverage for  $|\eta| < 3$
- Different technologies adopted for barrel and endcap: choice driven by radiation hardness, cost, power consumption/channel count



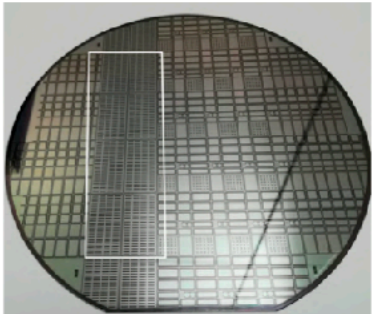
**BTL: LYSO bars + SiPM read-out**

- ▷ TK/ECAL interface  $\sim 45$  mm thick
- ▷  $|\eta| < 1.45$  and  $p_T > 0.7$  GeV
- ▷ Active area  $\sim 38$  m<sup>2</sup>; 332k channels
- ▷ Fluence at 3 ab<sup>-1</sup>:  $2 \times 10^{14}$  n<sub>eq</sub>/cm<sup>2</sup>



**ETL: Si with internal gain (LGAD)**

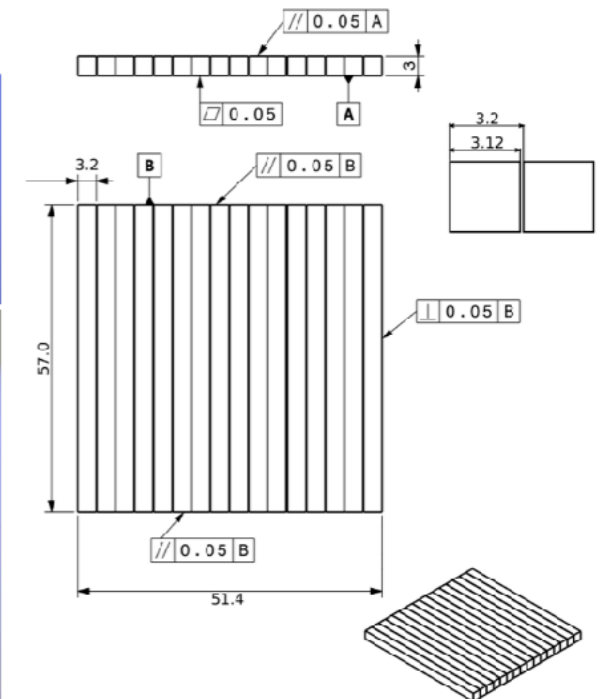
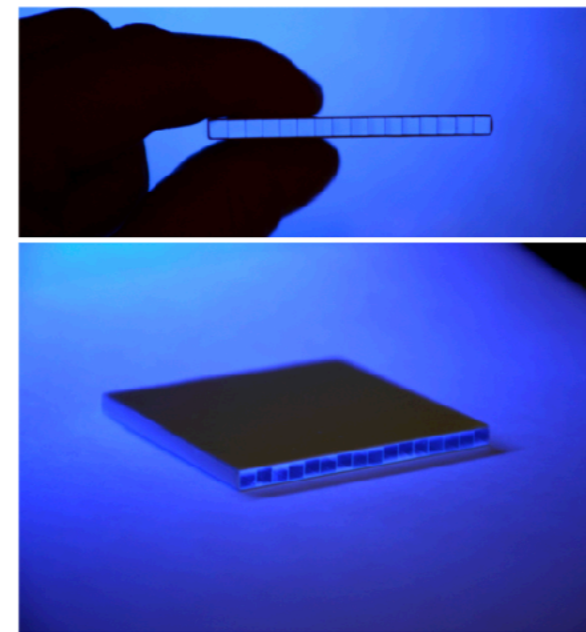
- ▷ On the HGC nose  $\sim 65$  mm thick
- ▷  $1.6 < |\eta| < 3.0$
- ▷ Active area  $\sim 14$  m<sup>2</sup>;  $\sim 8.5$ M channels
- ▷ Fluence at 3 ab<sup>-1</sup>: up to  $2 \times 10^{15}$  n<sub>eq</sub>/cm<sup>2</sup>



## Lutetium-Yttrium orthosilicate, Cerium doped crystals (LYSO:Ce)

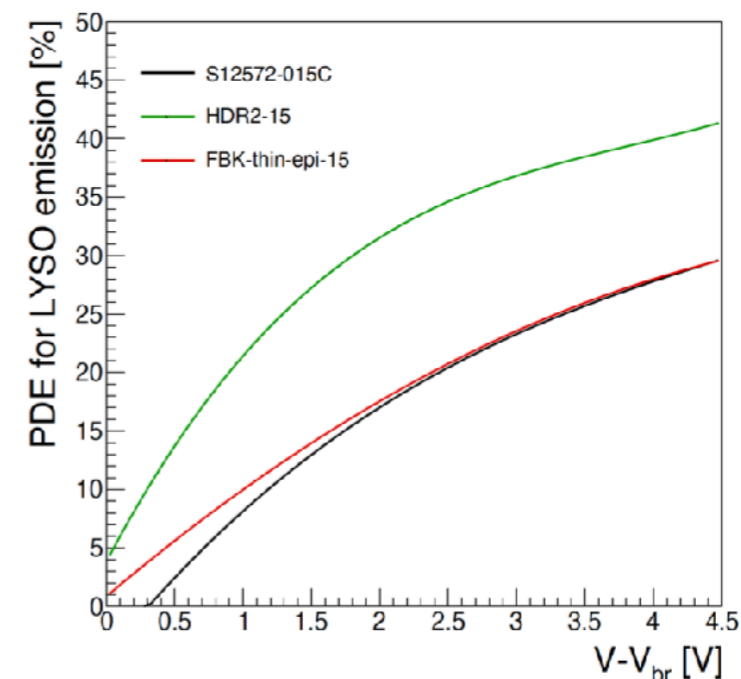
- High light yield (40k photons/MeV)
- Fast (40ns decay time)
- Dense (7.1 g/cm<sup>3</sup>), MIP deposit 4.2 MeV on average in BTL
- commercially available from several vendors (PET)
- Excellent radiation hardness up to tens of kGy

LYSO:Ce matrix 1x16



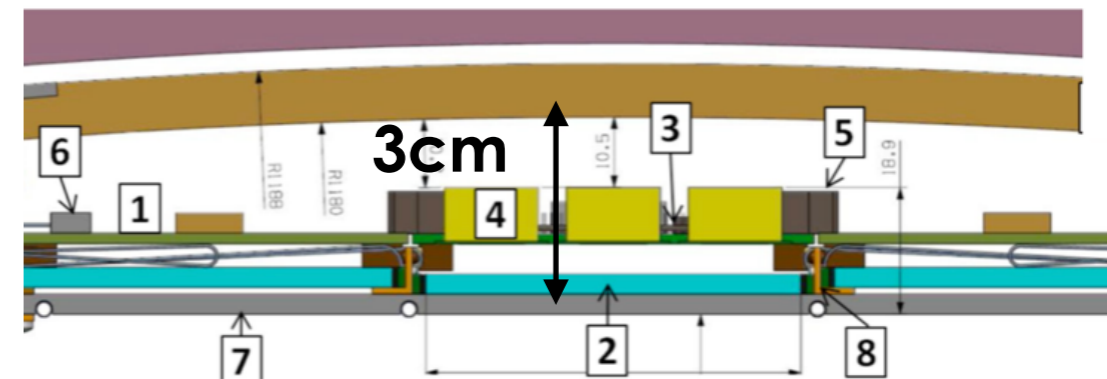
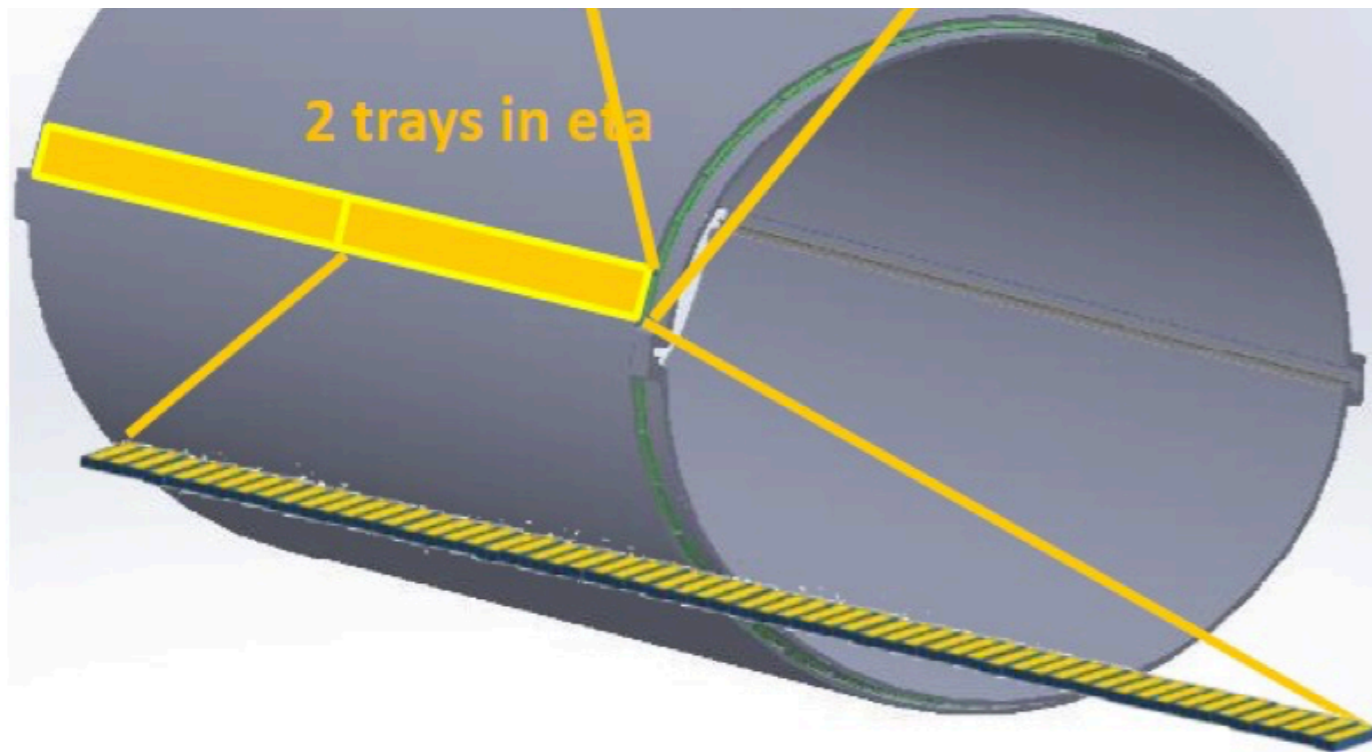
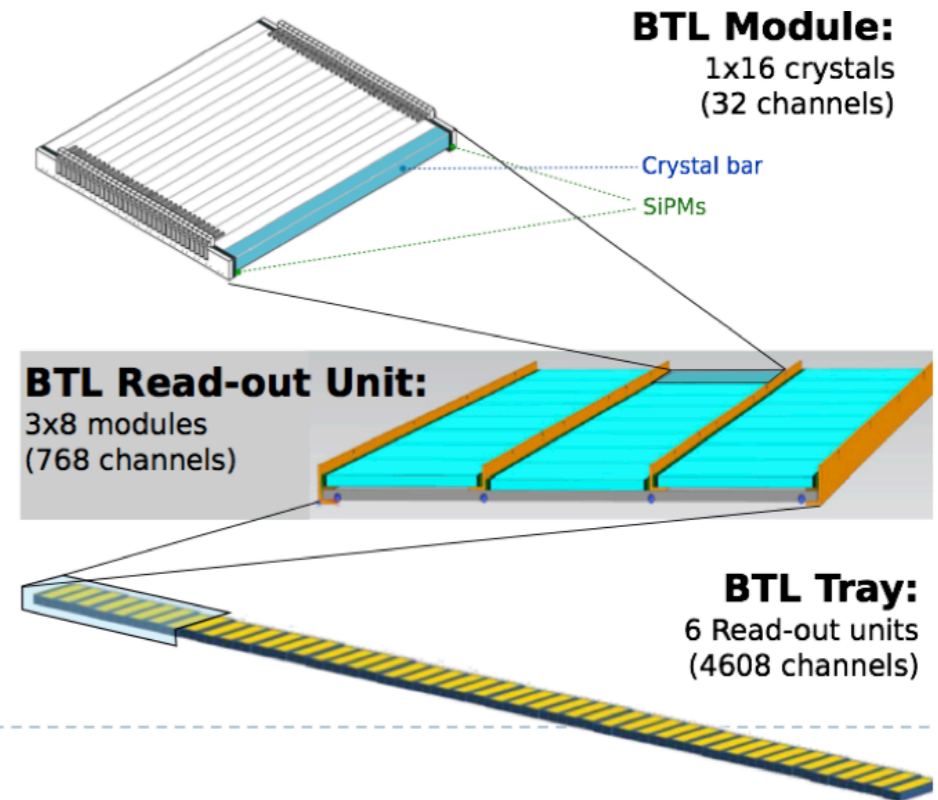
## Silicon Photomultipliers as photosensors

- Compact (SiPM+package ~1mm), fast, insensitive to magnetic field
- Photo detection efficiency PDE @ 420 nm (20-40%)
- SiPM active area (~9 mm<sup>2</sup>), match LYSO transverse size
- Optimal SiPM cell size compromise between PDE and radiation tolerance: 15μm
- High intrinsic gain: 1.5 - 4 x 10<sup>5</sup>



# BTL LAYOUT

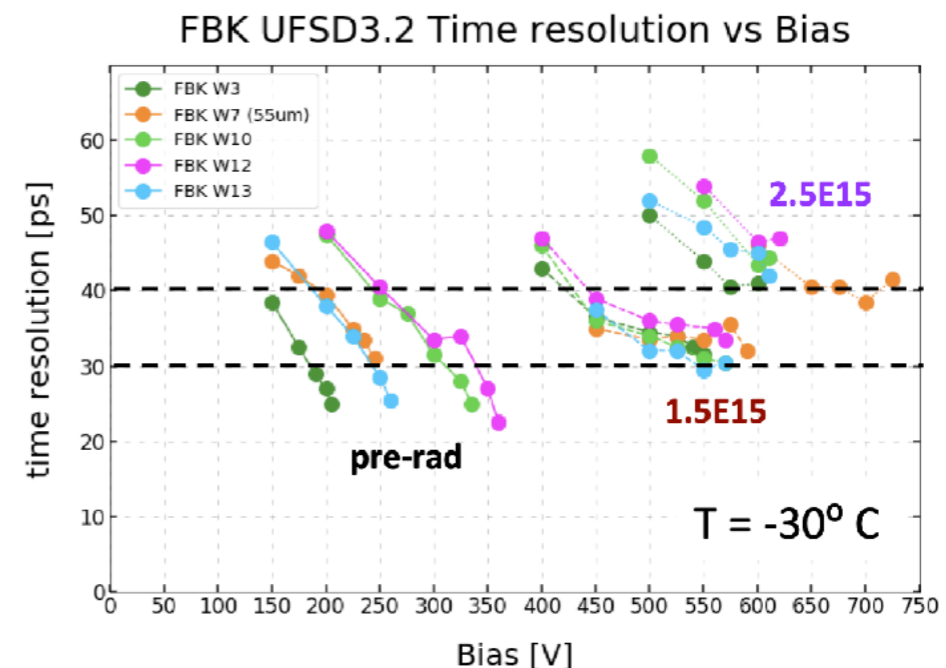
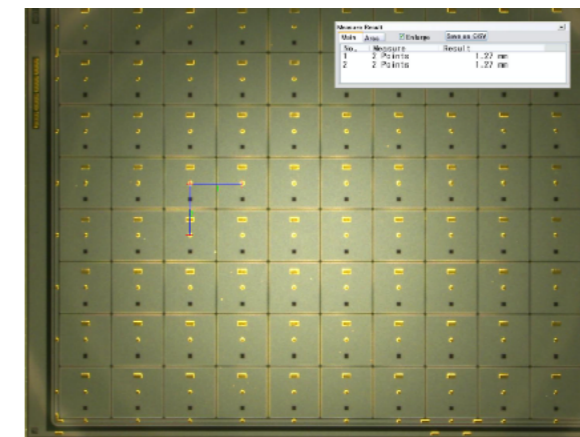
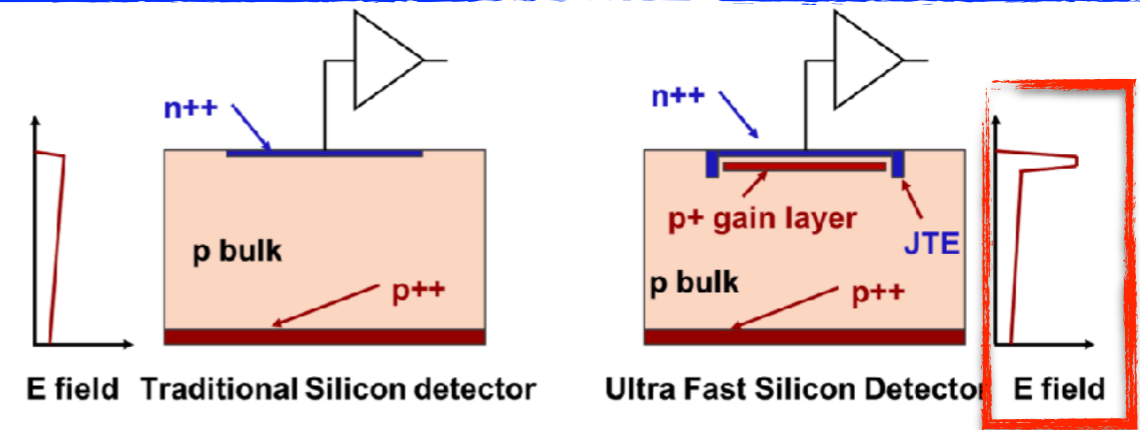
- Basic unit: array of 16 LYSO crystals (57mm length, 3.2mm pitch, 3 different thickness vs  $\eta$ ) + 2 SiPM linear arrays on both ends
- 72 trays on the inner surface of the tracker support tube,  $\sim 38\text{m}^2$
- Coverage  $|\eta| < 1.45$ , 332k channels



## Low gain avalanche silicon detectors (LGAD)

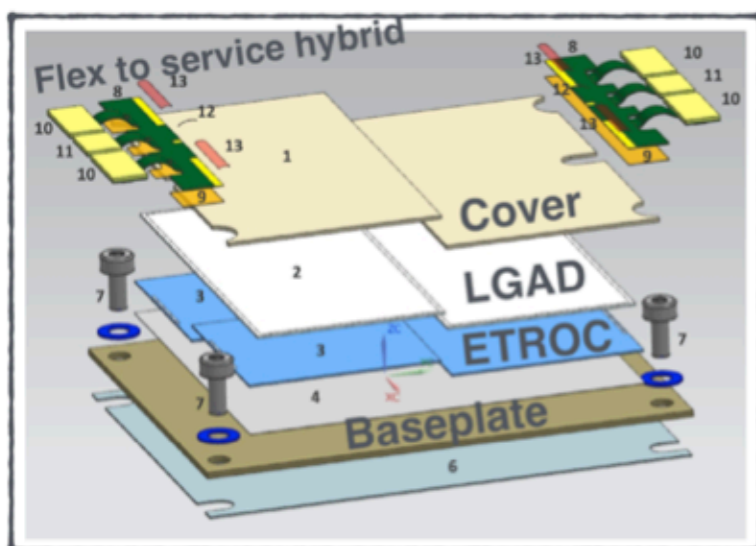
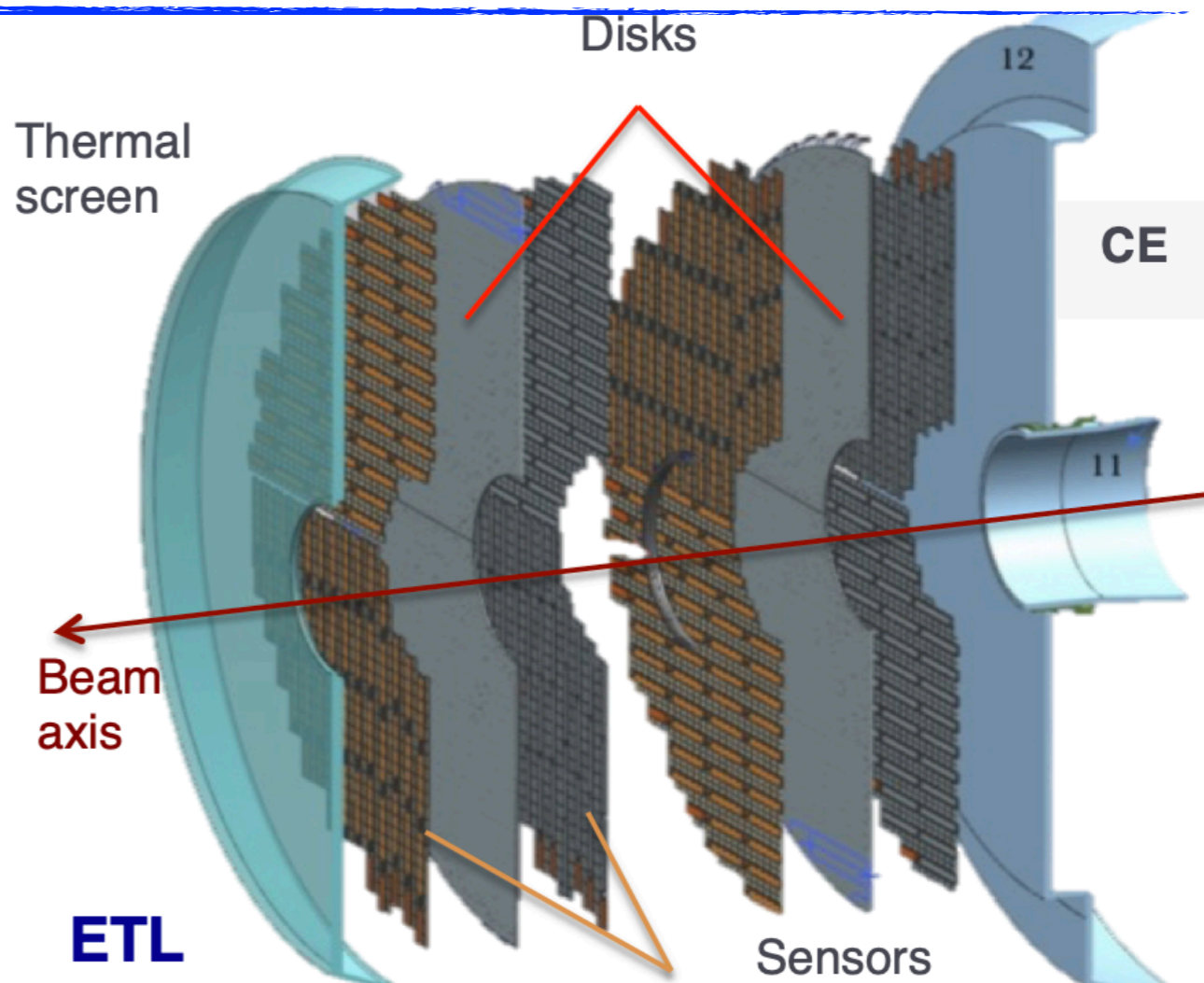
- Moderate internal gain (5-50) thanks to a dedicated gain layer: increase signal slew rate ( $dV/dt$ ) keeping low noise
- 50 $\mu\text{m}$  thickness
- Pixelated array: fill factor  $\sim 85\%$  for  $\sim 2\text{mm}^2$  pixel
- Operating voltage (reverse bias) up to  $\sim 700\text{V}$
- Radiation tolerance demonstrated up to  $2\text{E}15\text{ n}_{\text{eq}}/\text{cm}^2$

## Same technology also chosen for ATLAS HGTD

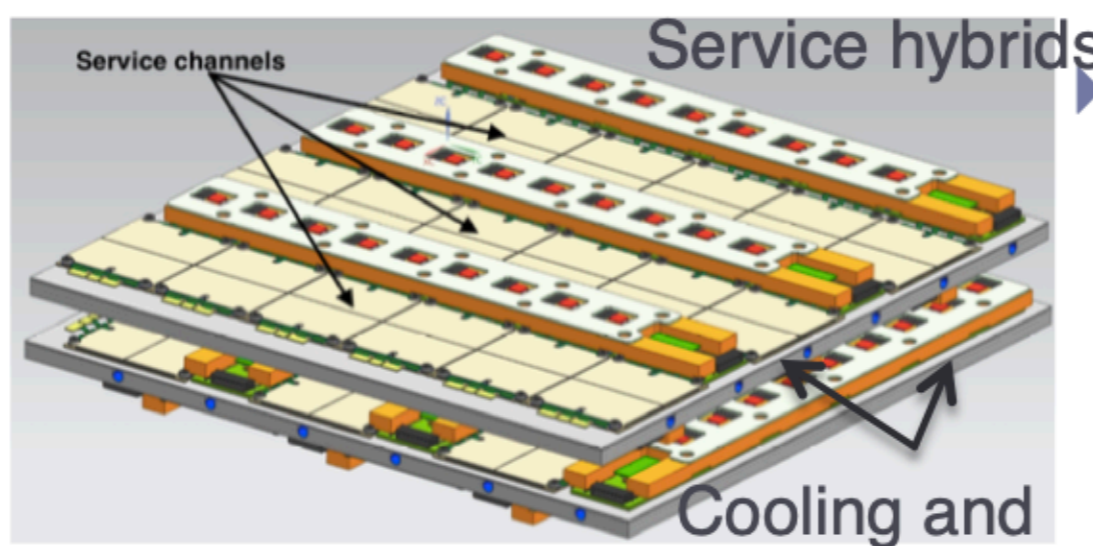


# ETL LAYOUT

- Basic unit: array of 16x32 LGADs, pad size 1.3 x 1.3 mm<sup>2</sup>
  - Sensor bump bonded to 2 readout chips
- 2 disks per endcap: staggered module layout on each side of each disk
- 2 hits per track: 30ps throughout HL-LHC
- Coverage  $1.6 < |\eta| < 3$ , 8.5M channels



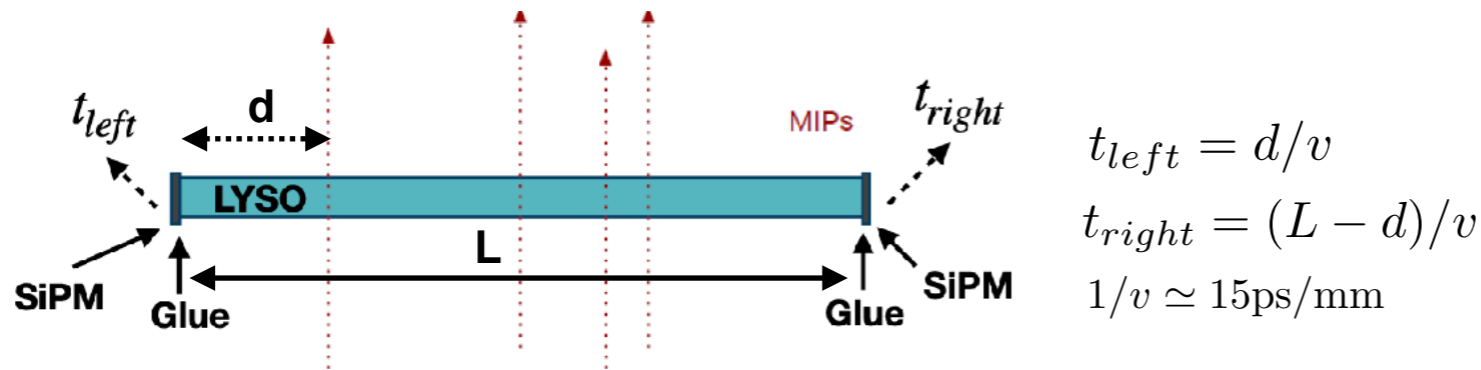
Module



Cooling and support structure



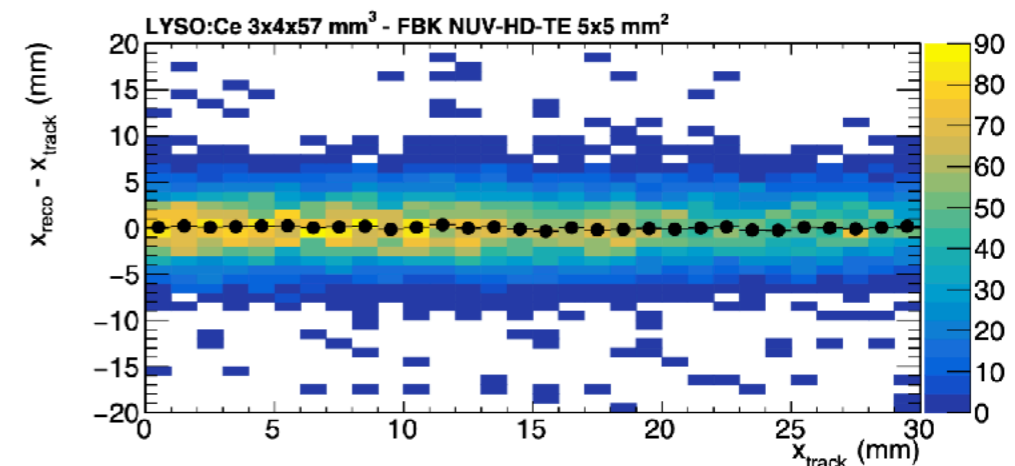
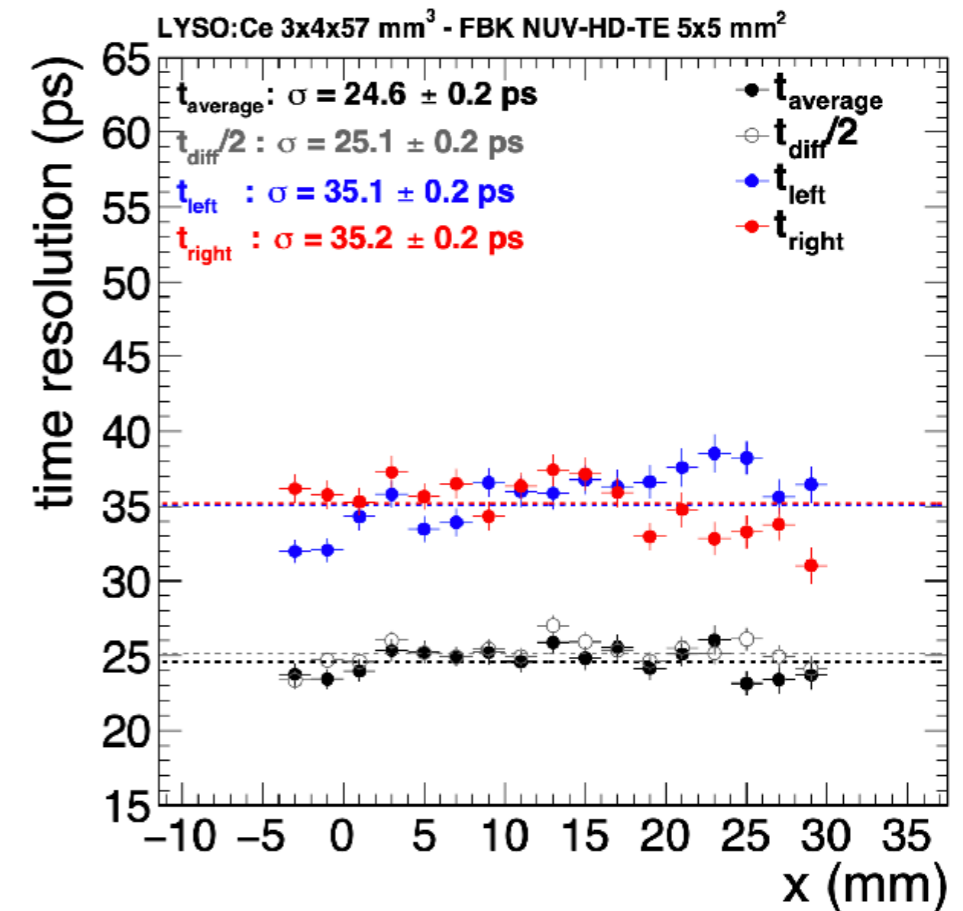
# BTL SENSOR: TEST BEAM PERFORMANCE



## SiPM readout on both ends of the LYSO bar

- 2 independent time measurements,  $t_{left}$  and  $t_{right}$
- Average time  $t_{ave} = (t_{left} + t_{right})/2$  provides optimal time measure independent of particle impact point
  - $\sqrt{2}$  gain compared to a single measurement
- From time difference  $t_{diff} = t_{left} - t_{right}$  charged particle impact position can be measured ( $\sim 3\text{mm}$  resolution)

Test beam studies confirm BTL expected performance: time resolution  $< 30\text{ps}$



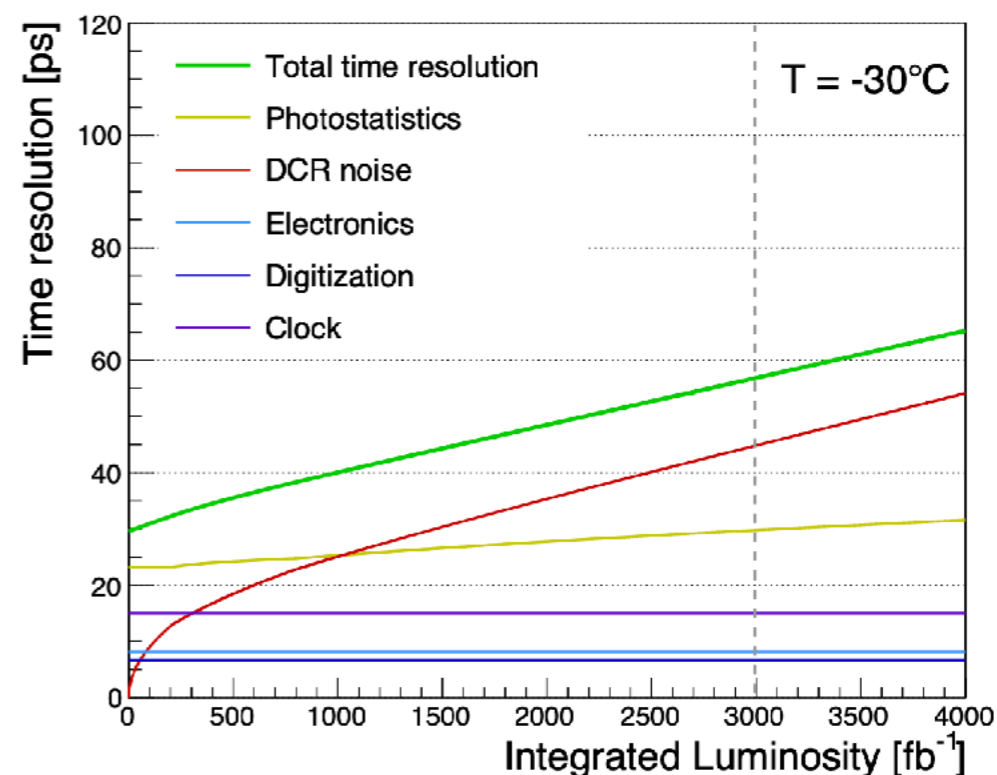
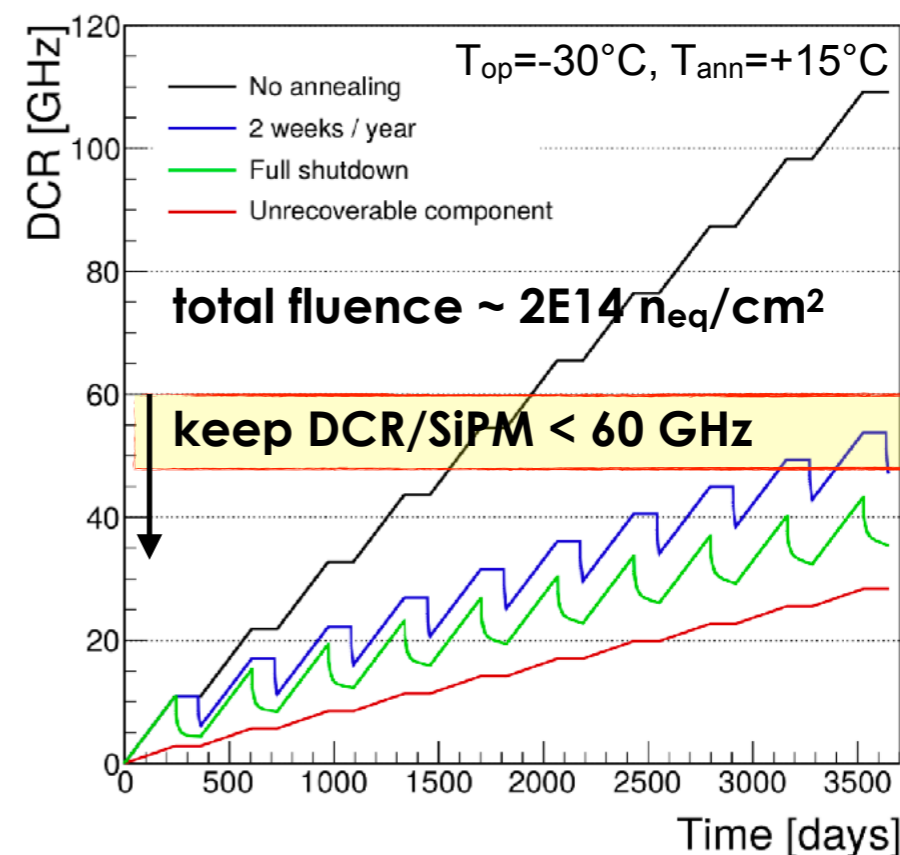
# BTL TIME RESOLUTION

## SiPM dark current increase due to radiation damage throughout HL-LHC

- Low temperature: DCR reduced by  $\sim 1/2$  every  $10^\circ\text{C}$ , operating temperature  $< -30^\circ\text{C}$  ( $\text{CO}_2$  cooling)
- Annealing during shutdown
- Increase of dark current limits also the SiPM operating voltage (limited power budget)
- Possibility to use small thermoelectric coolers on the SiPM package under discussion

## Time resolution $< 60\text{ps}$ after $3000\text{fb}^{-1}$

- Contribution from DCR noise becomes the largest contribution after  $1000\text{fb}^{-1}$
- Photostatistics dominant contribution at the begin of operations
- Electronics+clock distribution contribution  $\sim 15\text{ps}$

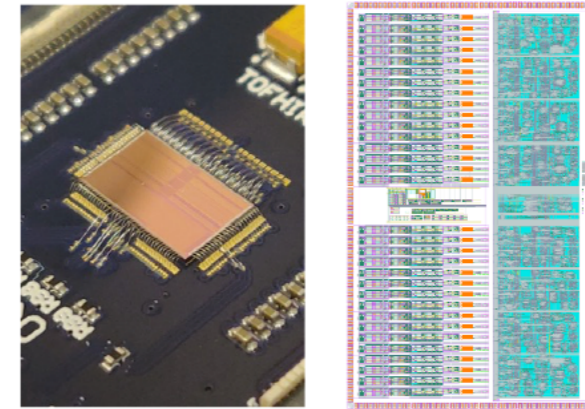




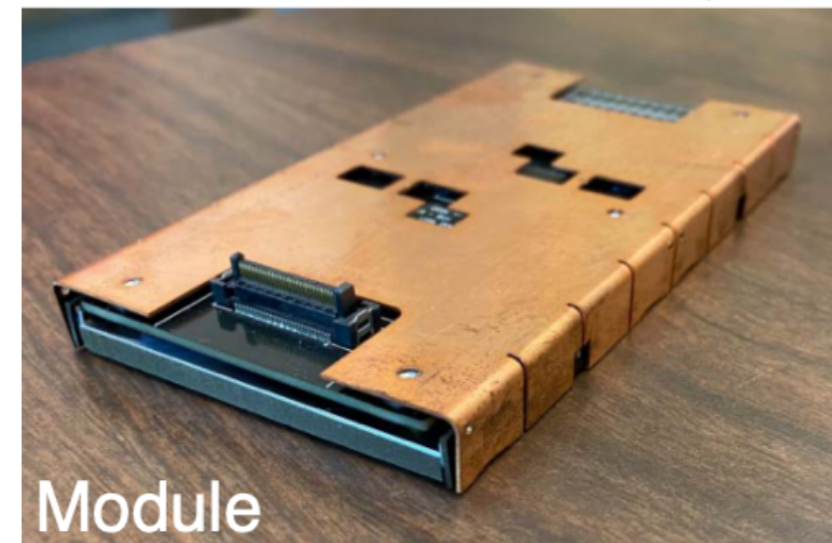
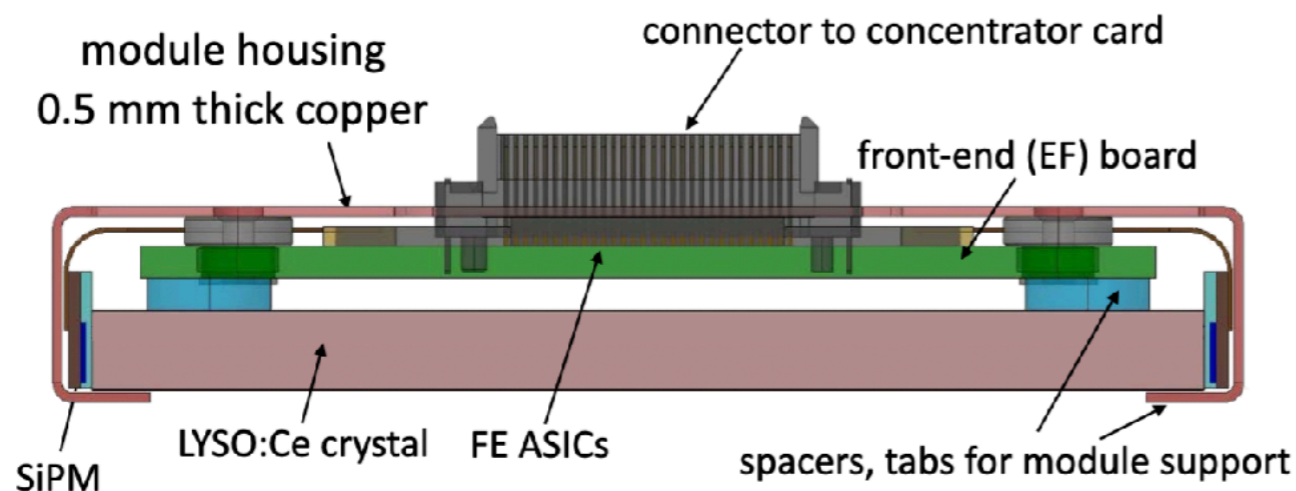
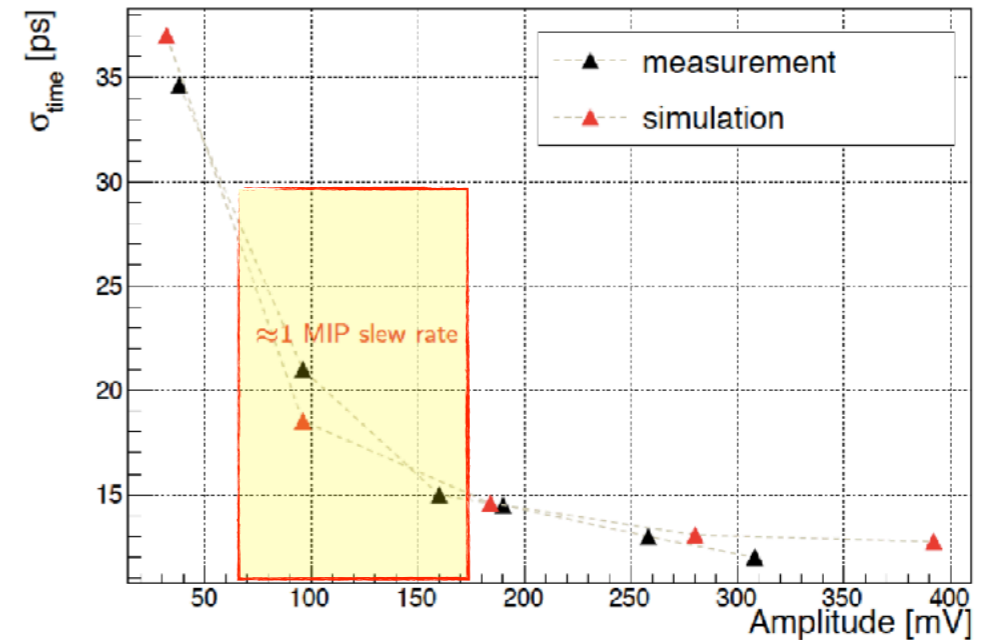
## A new ASIC developed: TOFHIR

### Time Of Flight at High Rate

- Analog+digital ASIC, based on TOFPET2, radiation hard technology (TSMC CMOS 130nm)
- DCR noise cancellation
- High hit rate: 2.5 MHz MIP hits/channel
- Power consumption: 15 mW/channel



## BTL module designed to minimise the distance between SiPM and ASIC



# MTD SCHEDULE

MTD HIGH LEVEL MILESTONES TIMELINE	2017				2018				2019				2020				2021				2022				2023				2024				2025				2026			
	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4	Q1	Q2	Q3	Q4
	TDR Submission								BTL EDR								ETL EDR																							
<b>Barrel Timing Layer</b>	Design - Demo.				Engin. - Proto.				Pre-prod.				Production and integration				Install.				Tracker Installation				Comm.															
Support structure & Install.					B.1t				SS1				SS2				SS3 A7 A8				A7e A8e																			
Modules and trays					B.06				A1				A2 A3				A4 A5 A6																							
SiPM					Si1				Si2				Si3 Si4 Si5 Si6																											
Crystal matrices					X1				X2 X3 X4 X5								A4																							
Front end boards					B.02				FE4 T1 T2				FE5 T3				FE6a FE6 FE7				FE8																			
FE ASIC (TOFHIR)					B.01				B.04 FE1a				FE1 FE2a				FE2 FE3																							
<b>Endcap Timing Layer</b>	Design - Demo.				Engineering - Prototyping				Pre-production				Production & integration				Install.																							
Installation																	SX5				A21 UX5																			
Integration																	A18				A19 A20																			
Support structures					SS1				SS2 SS3 SS4 SS5				SS6 SS7 SS8 SS9				SS10 SS11 SS12																							
Module assembly	E.01								A1 A2 A3 A4				A5 A6 A7				A8 A9 A10 A11				A12 A13 A14 A15 A16 A17																			
Bump bonding									A5 A6				A7				A8 A9				A10 A11																			
Sensors	E.02				E.04				Si1				Si2 Si3 Si4 Si5 Si6				Si7 Si8 Si9																							
Service hybrids									FE7 FE8				FE9				FE10 FE11				FE12																			
FE ASIC (ETROC)	E.03				E.05				FE1 FE2				FE3				FE4 FE5 FE6																							
Power supplies									E.SS.13				E.SS.14				B.SS.4				E.SS.15 E.SS.16				B.SS.5															
Back-end system					BE.1 BE.2				CL.1 CL.2				BE.3								BE.4 BE.5				BE.6															

**Schedule is very tight for BTL as installation should start before tracker**

- BTL integration 2022-2023, installation to start at the end of 2023, before LS3
- Market surveys ongoing for LYSO and SiPMs, towards the final tender+order (fall 2021)

**ETL schedule a bit more relaxed, can be installed either on surface or in the cavern after lowering HGC**

- ETL integration 2023-2024, installation (on surface) 2025 during LS3

**Steady progress despite COVID, small delays not impacting the critical path**

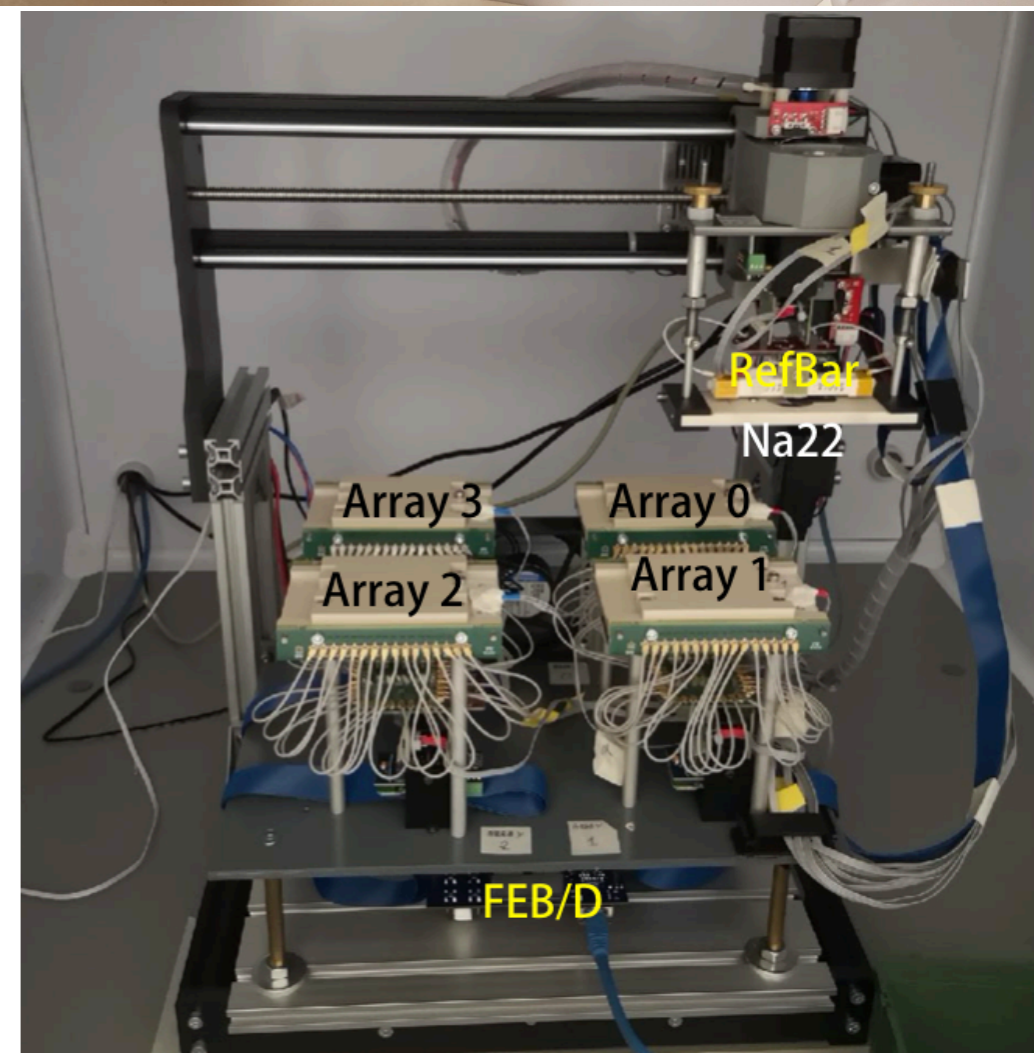
## Last step of LYSO vendor selection started 2 weeks ago in Rome

- LYSO is a "commercial" product (PET), several producers worldwide
- Now measuring about 300 arrays + 200 crystals from 9 vendors

## QA/QC during production will also be performed in Rome

Custom measurement benches developed for characterisation of LYSO up to  $-30^{\circ}\text{C}$   
Single LYSO crystals and arrays qualified in terms of

- light yield, decay time, time resolution, optical cross-talk (in arrays) measured using radioactive sources
- dimension, density, planarity (array) and uniformity



## **MTD is a major asset for the overall CMS physics programme at HL-LHC**

- Significant improvements on several observables from PU mitigation with precision timing (~30ps resolution)
- Physics gains for many final states are equivalent to ~25% more luminosity (few years of additional running of HL-LHC)
- New powerful handles for BSM (in particular LLP searches) and heavy flavour physics

## **MTD quickly moving into integration phase after several years of R&D**

- Novel detector technologies adopted for barrel and endcap, new ASICs developed, addressed several design challenges
- Several Italian groups are leading this effort since the very beginning of the project
- 2021 a key year for the project